# RA Family, RX Family, RL78 Family

## FS3000 Sample Software Manual

### Introduction

This application note describes the sample software that is for use with the FS3000 flow sensor and runs on certain MCUs of the RA family, and RX family, RL78 family.

### Target Devices

RA0E1 Group

RA2E1 Group

RX65N Group

RL78/G23 Group

### Target Sensor Board

Air Velocity Sensor Pmod™ Board (US082-FS3000EVZ)

The setting example described in this application note is an example when using the sensor board mentioned above.

Therefore, you will need to review the following settings according to the target circuit.

- Interrupt Signal Circuit: Refer to “6.4 Notes for Interrupt Signal Circuits”
- RESET Signal Circuit: Refer to “6.5 Notes for RESET Signal Circuits”.

When using this application note with other Renesas MCUs, careful evaluation is recommended after making modifications to comply with the alternate MCU.

## Contents

## Trademarks

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# 1. Overview

This sample software acquires data from the FS3000-1005 air flow sensor and handles calculations on the data. In combination with the I2C driver of the FSP or FIT, the sample software controls the FS3000-1005 through the I2C in the MCU to acquire ADC data from the sensor and calculate the air velocity.

## 1.1 Terms/Abbreviations

The terms and their abbreviations are listed below.

**Table 1-1 List of Terms/Abbreviations**

| Terms | Abbreviation |
|---|---|
| FS3000 Sensor Control Module | Sensor Control Module<br>When MCU is RA Family, “rm_fs3000”<br>When MCU is RX Family, “r_fs3000_rx”<br>When MCU is RL78 Family, “r_fs3000” |
| I2C Communication Middleware | COMMS_I2C<br>When MCU is RA Family, “rm_comms_i2c”<br>When MCU is RX Family, “r_comms_i2c_rx”<br>When MCU is RL78 Family, “r_comms_i2c” |
| I2C Driver | When MCU is RA Family, “r_iic_master”, “r_sci_i2c”, “r_iica_master”<br>When MCU is RX Family, “r_riic_rx”, “r_sci_iic_rx”<br>When MCU is RL78 Family, “r_iica_master” |
| Serial Communications Interface | When MCU is RA Family, “SCI”, “SCI I/F”<br>When MCU is RX Family, “SCI”, “SCI I/F” |
| Serial Array Unit | When MCU is RA Family, “SAU”, “SAU I/F”<br>When MCU is RL78 Family, “SAU”, “SAU I/F” |
| I2C Bus Interface | When MCU is RA Family, “IIC”, “IIC I/F”<br>When MCU is RX Family, “RIIC”, “RIIC I/F” |
| I2C Bus Interface (IICA) | When MCU is RA Family, “IICA”, “IICA I/F” |
| Serial Interface IICA | When MCU is RL78 Family, “IICA”, “IICA I/F” |
| General Term for I2C Bus Interface, I2C Bus Interface (IICA), Serial Interface (IICA) | “I2C I/F” |
| General Term for Interrupt Controller | “ICU I/F” (Interrupt Controller Unit) |
| General purpose I/O Port | “GPIO”, “GPIO I/F” |
| Pin No.1 (#1) of Renesas Pmod Type 6A Sensor Board | “IRQ#” (L output when an interrupt occurs) |

# 2. Environment for Confirming Operation

## 2.1 Environment for Confirming Operation on RA Family MCU

The operation of this software has been confirmed on the MCU of the RA family in the following environment.

### (1) Evaluation Kit for RA2E1 (EK-RA2E1)

**Table 2-1 Confirming Operating Environment for EK-RA2E1**

| Item | Description |
|---|---|
| Demonstration board | RTK7EKA2E1S00001BE (EK-RA2E1) |
| Microcontroller | RA2E1 (R7FA2E1A92DFM:64pin) |
| Operating frequency | 48MHz |
| Operating voltage | 5V |
| Integrated development environment | Renesas Electronics e$^2$ studio 2024-07 |
| C compiler | GNU ARM Embedded 13.2.1.arm-13-7 |
| Configuration options | ISO C99 (-std=c99)<br>Optimization Level: Default settings (-O2) |
| FSP | v5.5.0 |
| RTOS | FreeRTOS v10.6.1 |
| Emulator | On board (J-LINK) |
| Interposer | Interposer Board for Pmod Type2/3 to 6A (US082-INTERPEVZ) |
| Sensor board | Air Velocity Sensor Pmod Board (US082-FS3000EVZ) |

**Table 2-2 Amount of Memory Used in RA2E1 Group**

| Area | Size (Non-OS) [Bytes] | Size (FreeRTOS) [Bytes] |
|---|---|---|
| ROM | 1,548 | 3,478 (Nore 1) |
| RAM | 136 | 372 |

Note Memory size is calculated for the sample code, FS3000 sensor control module, and COMMS_I2C. They do not include the sizes of FreeRTOS threads for the FreeRTOS versions.

Note 1 This includes an increase of 1,572 bytes due to the Relax function.

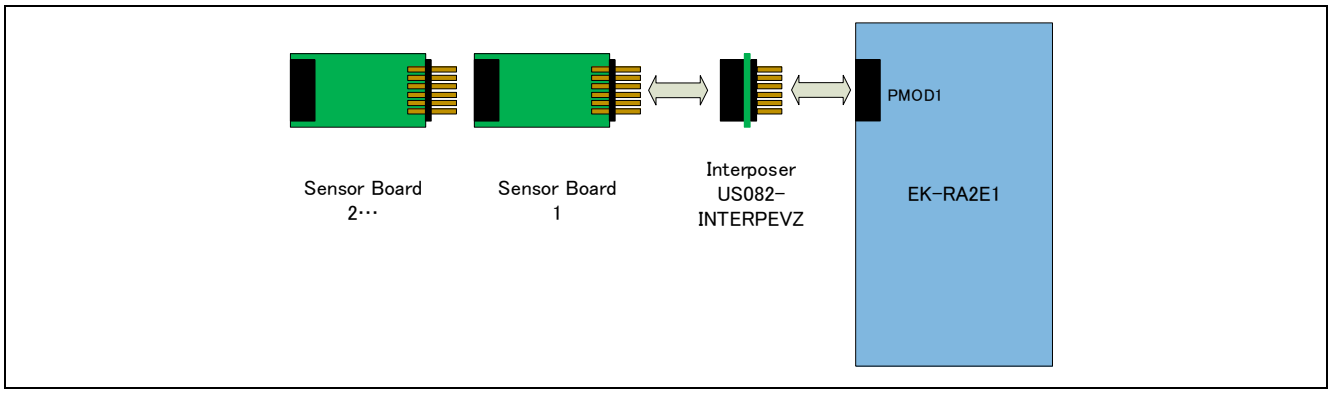



**Figure 2-1 Hardware Connections for EK-RA2E1**

### (2) RA0E1 Fast Prototyping Board (FPB-RA0E1)

**Table 2-3 Confirming Operating Environment for FPB-RA0E1**

| Item | Description |
|---|---|
| Demonstration board | RTK7FPA0E1S00001BJ (FPB-RA0E1) |
| Microcontroller | RA0E1 (R7FA0E1073CFJ:32pin) |
| Operating frequency | 32MHz |
| Operating voltage | 5V |
| Integrated development environment | Renesas Electronics e$^2$ studio 2024-07 |
| C compiler | GNU ARM Embedded 13.2.1.arm-13-7 |
| Configuration options | ISO C99 (-std=c99)<br>Optimization Level: Default settings (-Oz) |
| FSP | v5.5.0 |
| Emulator | On board (J-LINK) |
| Interposer | Interposer Board for Pmod Type2/3 to 6A (US082-INTERPEVZ) |
| Sensor board | Air Velocity Sensor Pmod Board (US082-FS3000EVZ) |

**Table 2-4 Amount of Memory Used in RA0E1 Group**

| Area | Size [Bytes] |
|---|---|
| ROM | 1,306 |
| RAM | 124 |

Note Memory size is calculated for the sample code, FS3000 sensor control module, and COMMS_I2C.

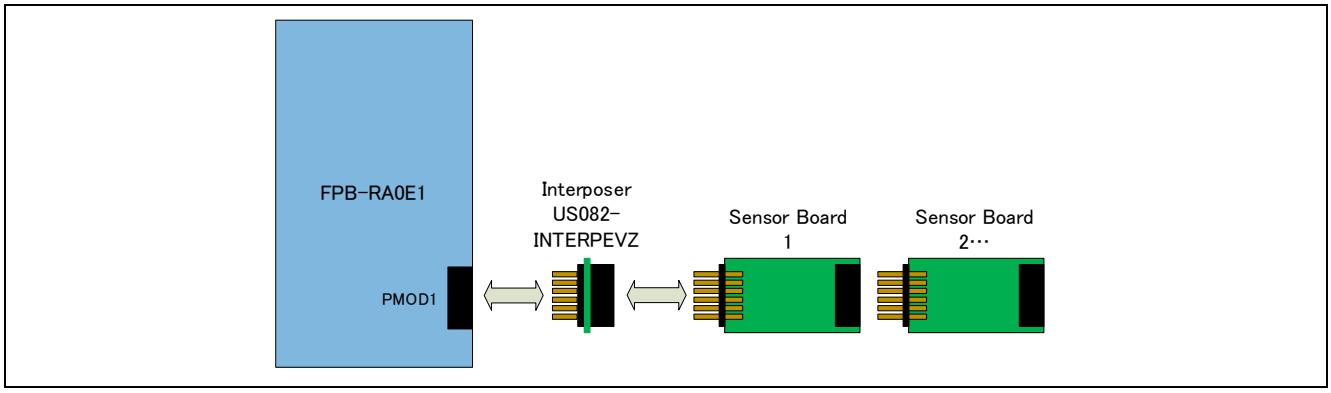



**Figure 2-2 Hardware Connections for FPB-RA0E1**

### (3) Use of Interposer Board

The Interposer Board is an I/F conversion board for connecting Pmod Type 6A sensors by switching the Pmod Type 2A/Type 3A connector of the SCI I/F to the Simple IIC function.

Therefore, it cannot be used with the Pmod Type 2A/Type 3A connector of the SAU I/F. However, it may be usable by switching to the IICA I/F. Refer to the MCU hardware manual.

**Table 2-5 Operational Feasibility Depending on Pmod I/F, Serial I/F, and Presence or Absence of Interposer Board**

| Pmod I/F | Destination MCU Serial I/F | Operational Feasibility |
|---|---|---|
| Type 2A,<br>Type 3A | SCI I/F,<br>IICA I/F (Note 1) | It works when using an Interposer Board. (Note 2) |
| | SAU I/F | It does not work regardless of whether the Interposer Board is present or not. |
| Type 6,<br>Type 6A | SCI I/F, IIC I/F,<br>SAU I/F, IICA I/F | It works without an Interposer Board. (Note 2) |

Note 1: These pins are provided for SAU I/F but can be used when it is switchable to IICA pins by multi-function pins assignment. The signal connections when switchable are shown below.

| Pmod Pin | Type 2A /Type 3A | Destination SAU I/F ICU I/F GPIO I/F | **Switching to Multi-Function IICA I/F** | Interposer Board | **Renesas Pmod Type 6A Sensor Board** |
|---|---|---|---|---|---|
| #1 | CS/CTS | **GPIO** | | ←→ | **IRQ# (Note 3)** |
| #2 | MOSI/TXD | SAU TXD | **SDAA** | ←→ | **RESET#** |
| #3 | MISO/RXD | SAU RXD | **SCLA** | ←→ | **IIC_SCL** |
| #4 | SCK/RTS | **GPIO** | | ←→ | **IIC_SDA** |
| #7 | INT | **IRQ#** | | ←→ | **BUSY#** |
| #8 | RESET | **GPIO** | | ←→ | **ENABLE** |
| #9 | CS2/GPIO | **GPIO** | | ←→ | **POWER_ON** |
| #10 | CS3/GPIO | **GPIO** | | ←→ | **GPIO** |

Note 2: If an IRQ signal is used, make sure that the IRQ signal is connected to Pmod #1 on the Pmod Sensor Board.

Note 3: For an interrupt signal circuit, refer to “6.4 Notes on Matching with Interrupt Signal Circuits”.

Application example: FPB-RA0E1 PMOD1 is applicable.

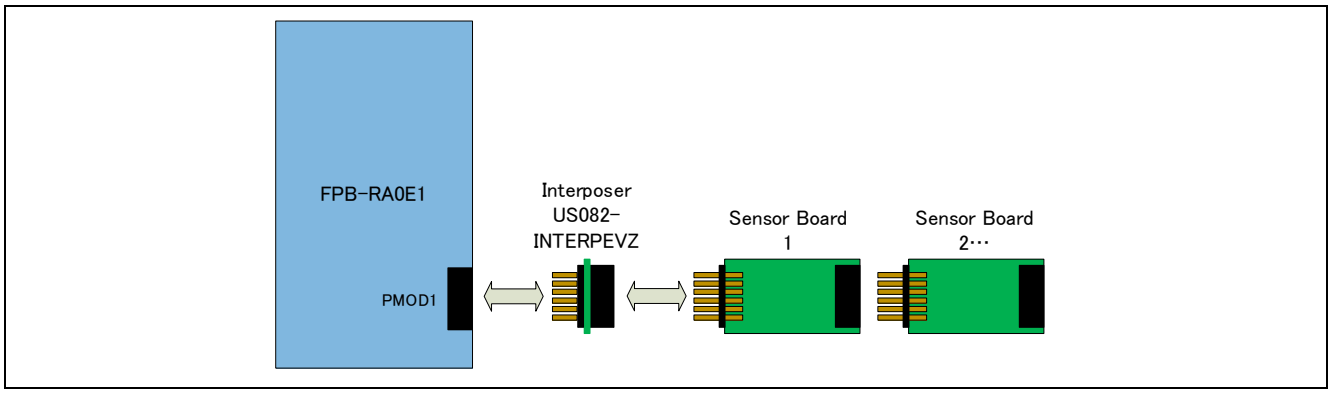



**Figure 2-3 Hardware Connections for using IICA at PMOD1 Type 2A, Type 3A on FPB-RA0E1**

## 2.2 Environment for Confirming Operation on RX Family MCU

The operation of this software has been confirmed on the MCU of the RX family in the following environment.

### (1) RX65N Envision Kit

**Table 2-6 Confirming Operating Environment for RX65N Envision Kit**

| Item | Description |
|---|---|
| Demonstration board | RPBRX65N (RX65N Envision Kit) |
| Microcontroller | RX65N (R5F565NEDDFB: 144pin) |
| Operating frequency | 120MHz |
| Operating voltage | 5V |
| Integrated development environment | Renesas Electronics e$^2$ studio 2024-07 |
| C compiler | Renesas Electronics CC-RX V.3.02.00 |
| Configuration options | C99 (-lang = c99)<br>Optimization Level: Default settings (Level 2) |
| FIT | Board Support Packages (r_bsp) v7.20<br>FS3000 Sensor Middleware (r_fs3000_rx) v1.00<br>IIC Communication Driver Interface Middleware (r_comms_i2c_rx) v1.20<br>RIIC Multi Master I2C Driver (r_riic_rx) v2.49<br>Simple IIC Driver (r_sci_iic_rx) v2.49 |
| RTOS | FreeRTOS Kernal 10.4.3-rx-1.0.1、FreeRTOS Object 10.4.3-rx-1.0.1 |
| Emulator | On board (E2OB) |
| Interposer | Interposer Board for Pmod Type2/3 to 6A (US082-INTERPEVZ) |
| Sensor board | Air Velocity Sensor Pmod Board (US082-FS3000EVZ) |

**Table 2-7 Amount of Memory Used in RX65N Group**

| Area | Size (Non-OS) [Bytes] | Size (FreeRTOS) [Bytes] |
|---|---|---|
| ROM | 1,638 | 1,844 |
| RAM | 118 | 141 |

Note Memory size is calculated for the sample code, FS3000 sensor control module, and COMMS_I2C. They do not include the sizes of FreeRTOS threads for the FreeRTOS versions.

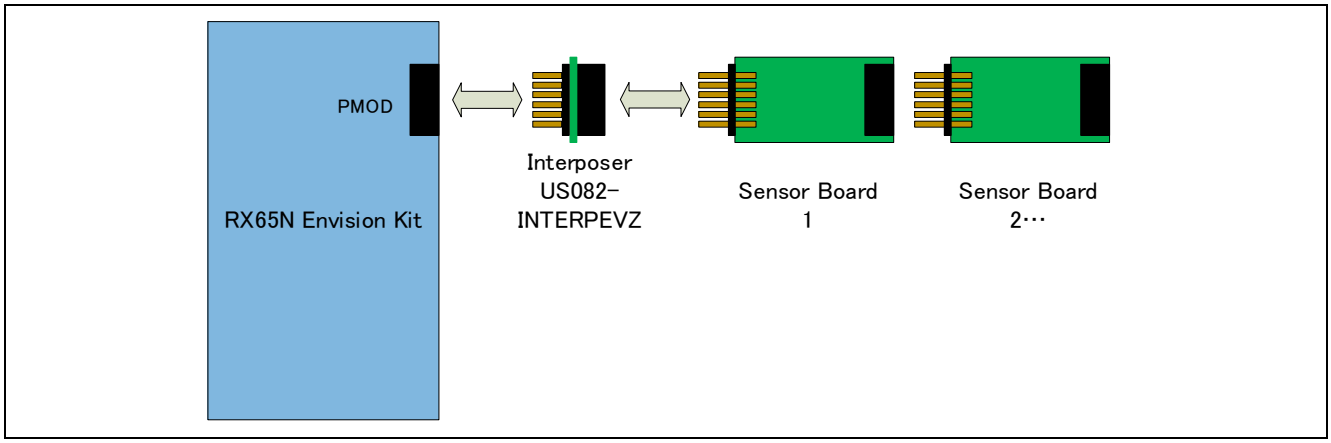



**Figure 2-4 Hardware Connections for RX65N Envision Kit**

### (2) Use of Interposer Board

If you add an Interposer Board to the Pmod Type 2A/Type 3A connector to which the SCI I/F is connected, you can use the Pmod Type 6A Sensor Pmod Board.

## 2.3 Environment for Confirming Operation on RL78 Family MCU

The operation of this software has been confirmed on the MCU of the RL78/G23 group in the following environment.

### (1) RL78/G23-128p Fast Prototyping Board (RL78/G23-128p FPB)

**Table 2-8 Confirming Operating Environment for RL78/G23-128p FPB**

| Item | Description |
|---|---|
| Demonstration board | RTK7RLG230CSN000BJ (RL78/G23-128p FPB) |
| Microcontroller | RL78/G23 (R7F100GSN2DFB: 128 pins) |
| Operating frequency | 32MHz |
| Operating voltage | 3.3V |
| Integrated development environment | Renesas Electronics e$^2$ Studio 2024-07 |
| C compiler | Renesas Electronics CC-RL V1.14.00<br>LLVM for RL78 17.0.1.202409 |
| Configuration options | Add the following settings to the compiler default settings.<br>CC-RL: C99 (-lang = c99), Optimization Level: Default settings (-Odefault)<br>LLVM: GNU ISO C99 (-std = gnu99), Optimization Level: Default settings (-Og) |
| SIS / CG | Board Support Packages (r_bsp) v1.70<br>FS3000 Sensor Middleware (r_fs3000) v1.02<br>IIC Communication Driver Interface Middleware (r_comms_i2c) v1.11<br>IIC Communication (Master mode) v1.6.0 |
| Emulator | On board (COM Port) |
| Sensor board | Air Velocity Sensor Pmod Board (US082-FS3000EVZ) |

**Table 2-9 Amount of Memory Used in RL78/G23 Group**

| Area | Size [Bytes] (CC-RL) |
|---|---|
| ROM | 1,905 |
| RAM | 85 |

Note Memory size is calculated for the sample code, FS3000 sensor control module, and COMMS_I2C.

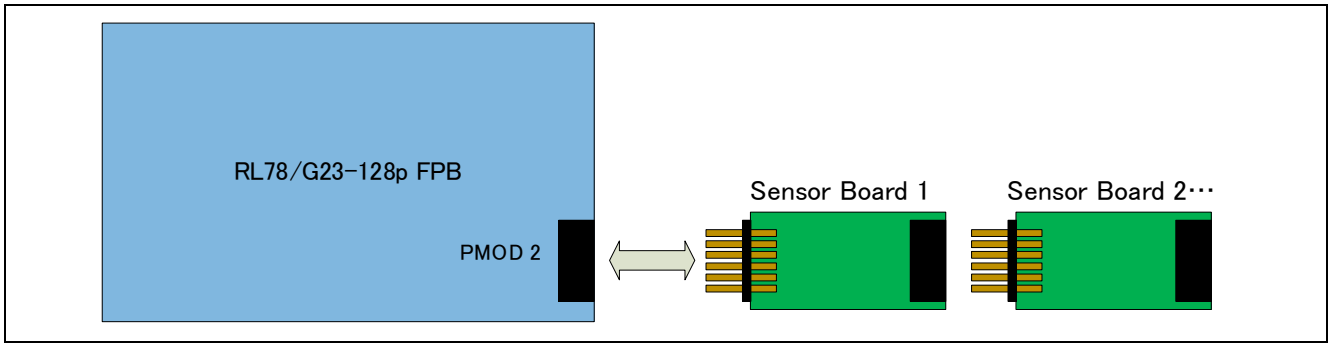



**Figure 2-5 Hardware Connections for RL78/G23-128p FPB**

### (2) Use of Interposer Board

The Interposer Board is an I/F conversion board for connecting a Pmod Type 6A sensor by switching the Pmod Type 2A/Type 3A connector of an SCI I/F for RA/RX to the Simple IIC function.

Therefore, even if the Interposer Board is added to a Pmod Type 2A/Type 3A connector to which an SAU I/F is connected, the Pmod Type 6A Sensor Pmod Board **cannot be used**.

# 3. Sensor Specifications

## 3.1 Overview of Sensor Specifications

The FS3000 is a surface-mount type air velocity module utilizing a MEMS thermopile-based sensor. The FS3000 features a digital output with 12-bit resolution. Please refer to the FS3000 datasheet for more information about the sensor module, including parameters that describe the module's characteristics.

## 3.2 Sensor Functions

The FS3000 sample software supports the FS3000-1005 air flow sensor; it does not support the FS3000-1015 sensor.

The sensor begins measurement as soon as the power supply is turned on.

To obtain data from the sensor, send the Flow Data Read command and then read the five bytes of data. For commands, please refer to the FS3000 datasheet.

The air velocity is represented by 12 bits; the four lower-order bits of the second byte (Byte 2) are valid.

# 4. Sample Software Specifications

This sample software package contains a total of 7 projects: non-OS and OS (FreeRTOS) versions for the RA2E1 group, non-OS version for the RA0E1 group, non-OS and OS (FreeRTOS) versions for the RX65N group, and a non-OS version (CC-RL / LLVM) for the RL78/G23 group. This section describes these projects.

For the FreeRTOS settings for the RX family, refer to the FAQ.

## 4.1 Configuration of Sample Software

Figure 4-1 Layer diagram of Sample Software shows structure of sample software layer.

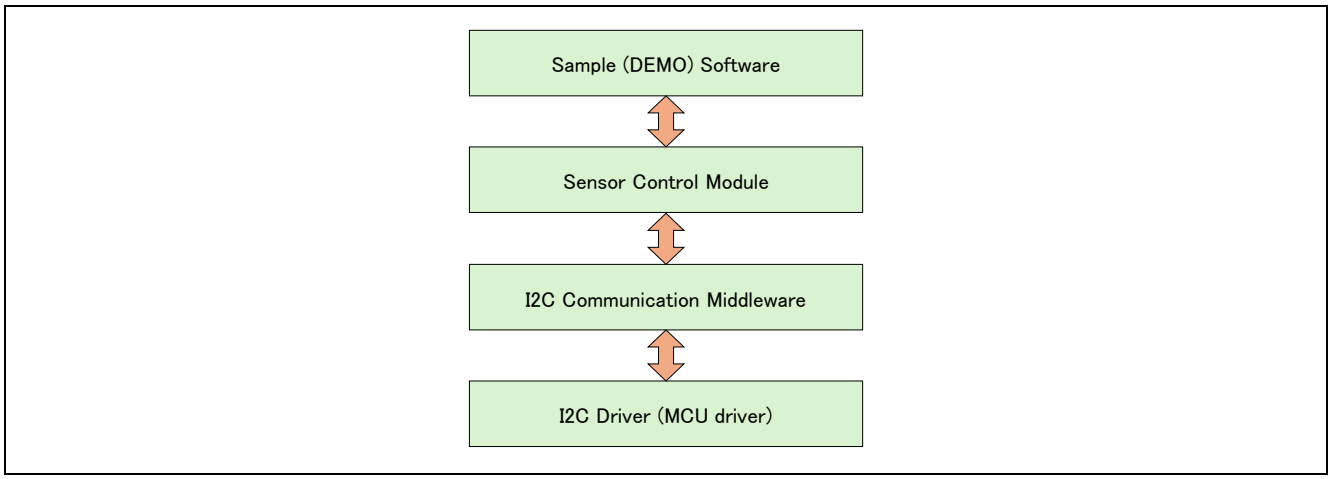



**Figure 4-1 Layer diagram of Sample Software**

## 4.2 Specifications of Sensor API Functions

### 4.2.1 List of Sensor API functions

The Sensor Control Module API includes the following functions.

For details on the Function API, see below.

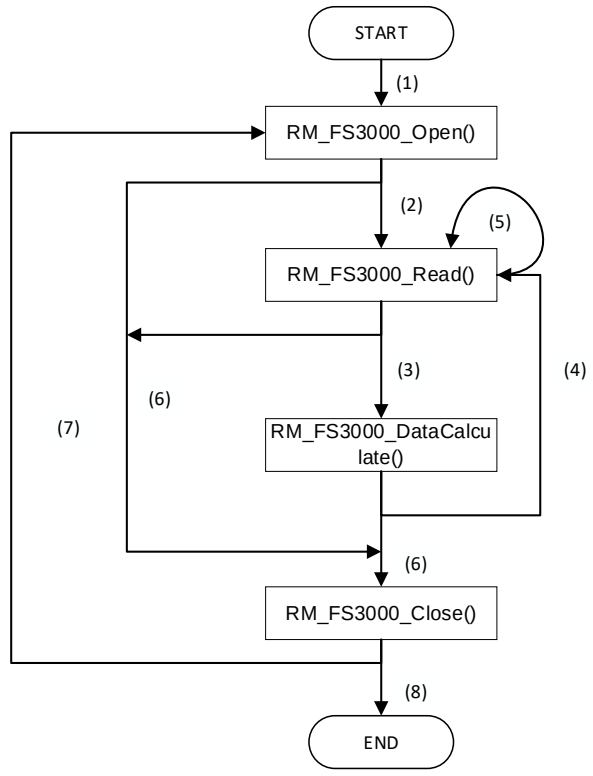
RA Flexible Software Package Documentation
Renesas Sensor Control Modules Firmware Integration Technology
Renesas Sensor Control Modules Software Integration System

**Table 4-1 List of Sensor API Functions**

| Function | Description |
|---|---|
| RM_FS3000_Open() | Starts control of the sensor. |
| RM_FS3000_Close() | Terminates control of the sensor. |
| RM_FS3000_Read() | Acquires data from the sensor. |
| RM_FS3000_DataCalculate() | Calculates values from the data acquired from the sensor. |

### 4.2.2 Guide to Using API Functions

The following shows the transition diagram of functions calling order as the usage condition of API functions.




| Flow No. | Function | Transition Case |
|---|---|---|
| (1) | Start FS3000 | not open FS3000 |
| (2) | ADC Read | open success |
| (3) | calculate | ADC read success (callback state success) |
| (4) | next read ADC | DataCalculate return success and next ADC data Get |
| (5) | get retry ADC data | user get retry ADC data or DataCalculate return invalid data |
| (6) | Close FS3000 | Error state or user stop |
| (7) | Restart FS3000 | Close success and user restart |
| (8) | Stop FS3000 | Close success or Error |

**Figure 4-2 Diagram of Transitions between API Function Calls**

The conditions for calling the individual functions are shown below.

- RM_FS3000_Open() (1) Activation of FS3000 or
  (7) Restart after a call of RM_FS3000_Close()
- RM_FS3000_Close() (6) Successful completion or abnormal end of individual processing
- RM_FS3000_Read() (2) Acquisition of measured data after the start of measurement or
  (5) Retry after waiting for the response to the data acquisition request
- RM_FS3000_DataCalculate() (3) Calculation of data after a call of RM_FS3000_Read()

Note: When using an OS and controlling the sensor with multiple threads or tasks simultaneously in use, the user will need to use a semaphore to control the bus. For the timing of the semaphore being raised and the control of blocking, refer to section “4.4 Flowchart of OS Version of Sample Software”.

## 4.3 Flowchart of Main Processing in Non-OS Version of Sample Software

This sample software first starts the driver and then repeats the processing for acquiring data from the sensor and calculating values from the results of measurement.

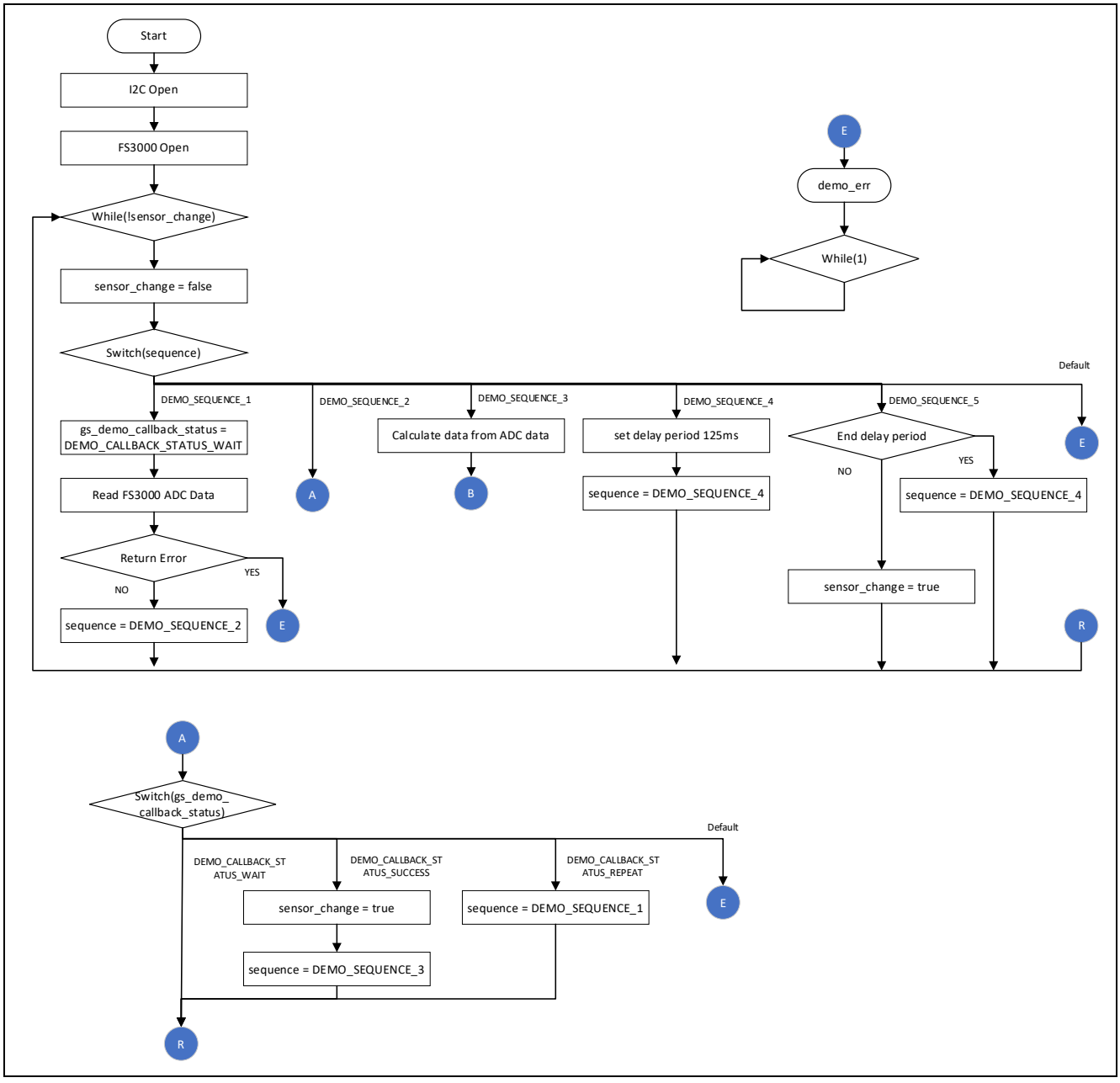



**Figure 4-3 Flowchart of Main Processing in Non-OS Version of FS3000 Sample Software (1)**

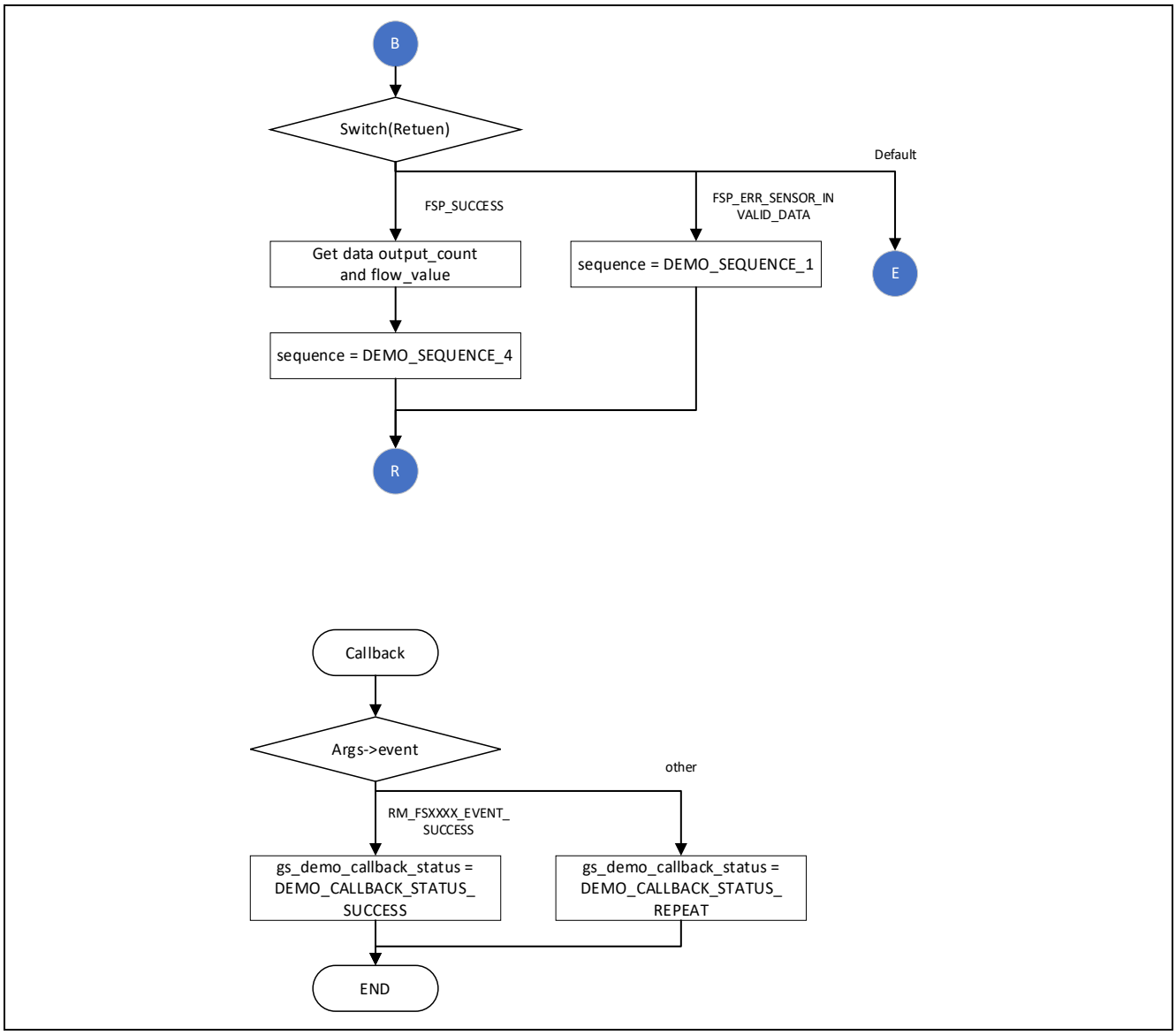



**Figure 4-4 Flowchart of Main Processing in Non-OS Version of FS3000 Sample Software (2)**

## 4.4 Flowchart of OS Version of Sample Software

The OS version uses a semaphore in control of the sensor and operates two threads for controlling the sensor in parallel.

The sensor control in each thread first starts the driver and then repeats the processing for acquiring data from the sensor and calculating values from the results of measurement.

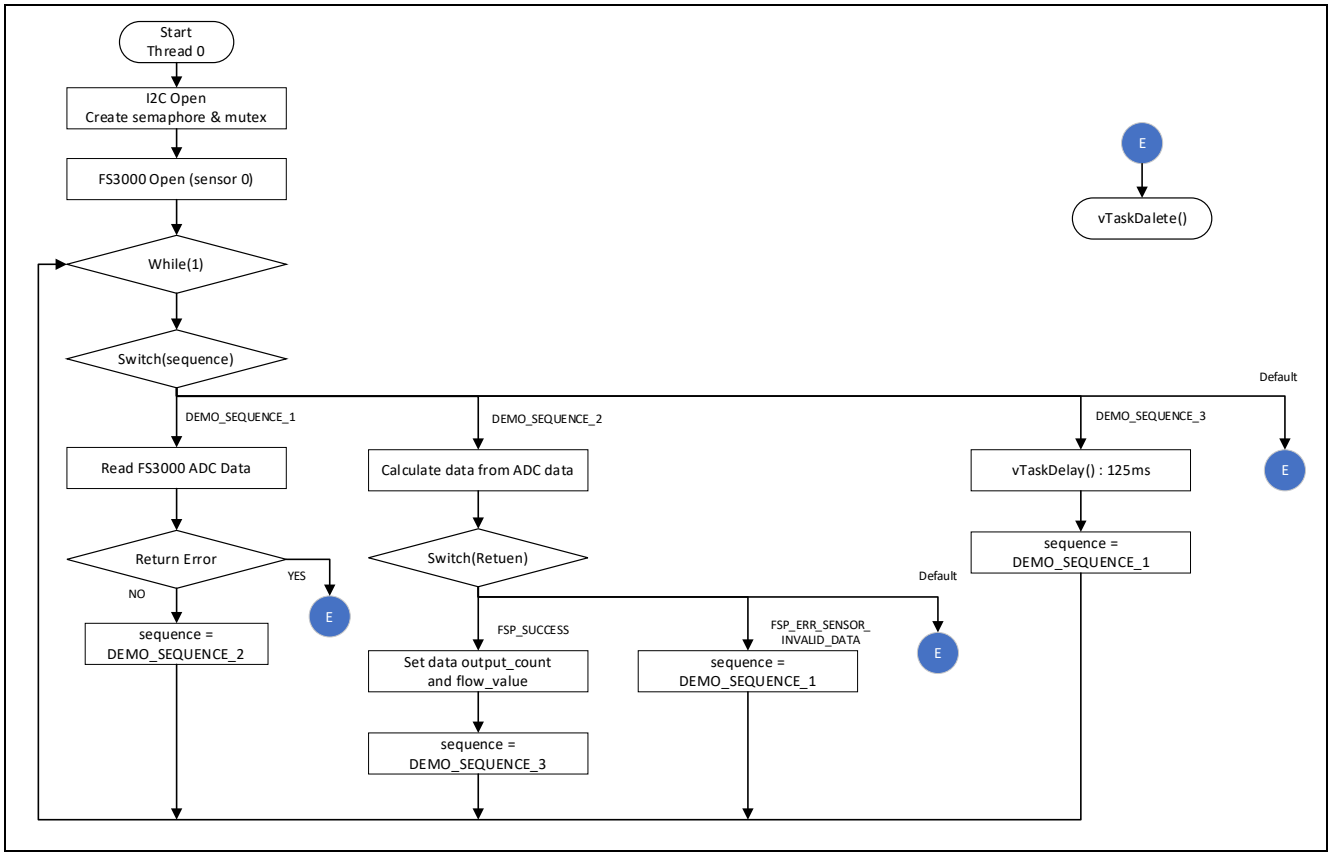



**Figure 4-5 Flowchart of Main Processing in OS Version of FS3000 Sample Software (1)**

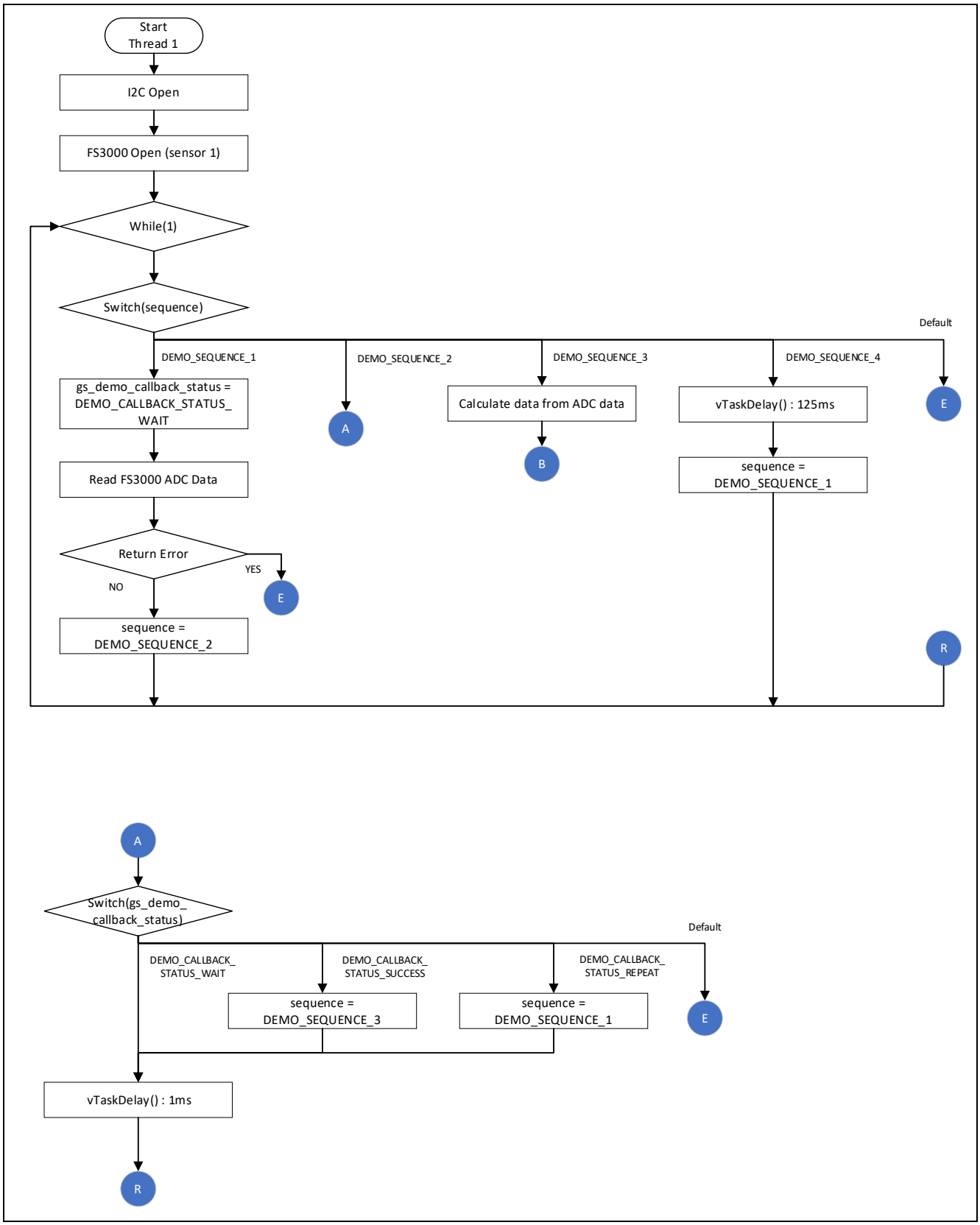



**Figure 4-6 Flowchart of Main Processing in OS Version of FS3000 Sample Software (2)**

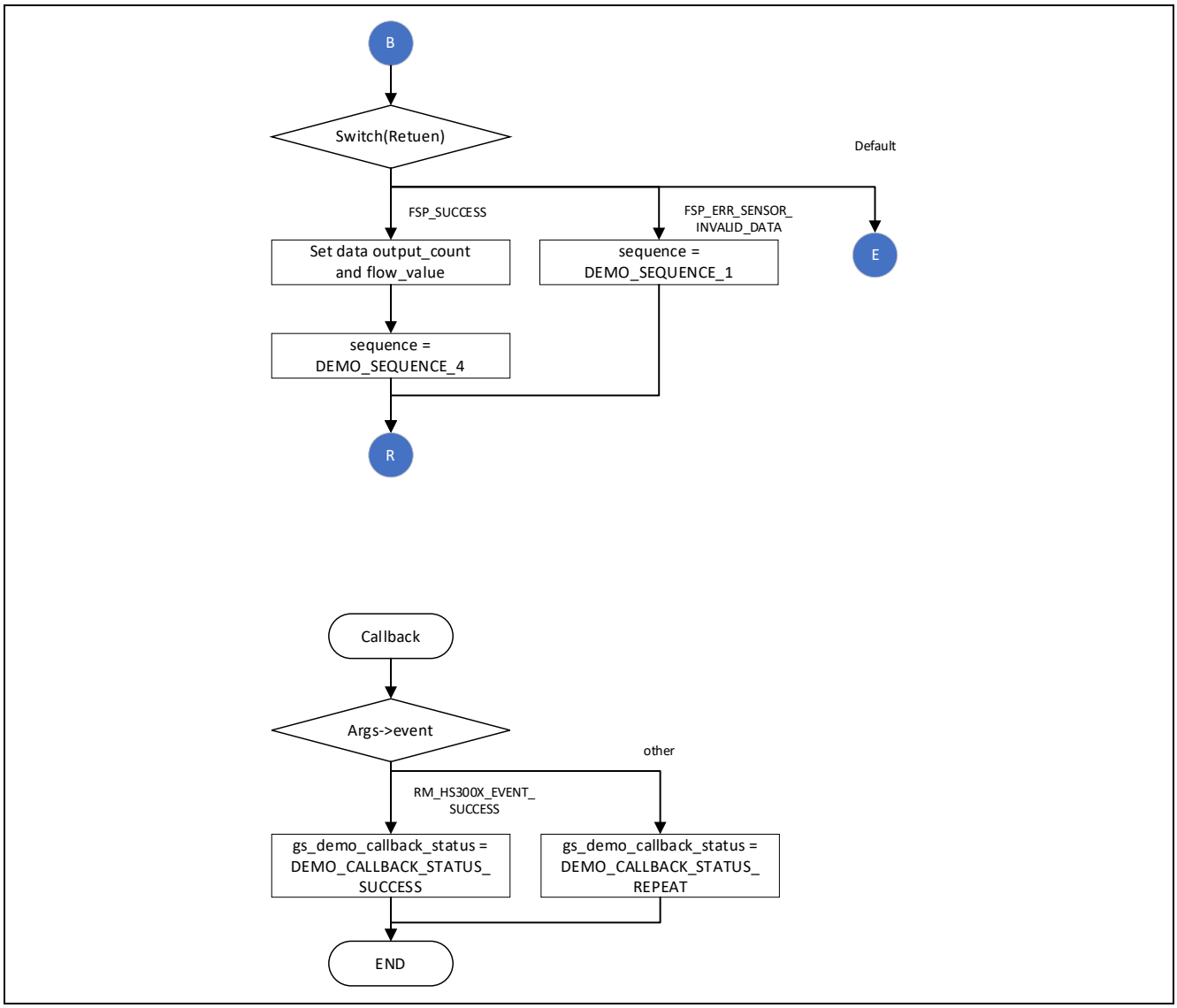



**Figure 4-7 Flowchart of Main Processing in OS Version of FS3000 Sample Software (3)**

# 5. Configuration Settings

The following items and values can be specified.

Green setting value is an item selected by default, and Orange setting value is an item that cannot be changed.

For module names and callback function names, specify names that conform to the C language standard.

When using the latest version, the settings items and values shown below may differ.

## 5.1 FS3000 Air Velocity Sensor Settings

### 5.1.1 RA Family

Select the **"rm_fs3000"** stack in the "Stack" tabbed page of the FSP Configurator, and the configurable items are shown in the "Properties" tabbed page.

**Table 5-1 FS3000 Settings for RA Family**

| Configurable Item | Value | Description |
|---|---|---|
| Common | | |
| Parameter Checking | Default (BSP) | Specify the include parameter check processing in code.<br>When "Disabled" is specified, excluding in the code.<br>When "Enabled" is specified, including in the code. |
| | Enabled | |
| | Disabled | |
| Device type | FS3000-1005 | Specify the type of device to be acquired from the sensor.<br>"FS3000-1005" only can be selected. |
| Module g_fs3000_sensor FS3000 on rm_fs3000 | | |
| Name | g_fs3000_sensor0 | Specify the name of the module. |
| Callback | fs3000_callback | Specify the name of the user callback function.<br>When "NULL" is specified, no callback function is used. |

### 5.1.2 RX Family

Select the **"r_fs3000_rx"** component in the "Component" tabbed page of the Smart Configurator, and the configurable items are shown in the "Configure" panel.

**Table 5-2 FS3000 Settings for RX Family**

| Configurable Item | Value | Description |
|---|---|---|
| Configurations | | |
| Parameter Checking | System Default | Specify the include parameter check processing in code.<br>When "Disabled" is specified, excluding in the code.<br>When "Enabled" is specified, including in the code. |
| | Enabled | |
| | Disabled | |
| Number of FS3000 sensors | 1 | Specify the number of FS3000 sensors. |
| | 2 | |
| Device type of FS3000 Sensors | FS3000-1005 | Specify the type of sensor.<br>"FS3000-1005" only can be selected. |
| I2C Communication device No. for FS3000 sensor device{x}<br>(x = 0 or 1) | I2C Communication Device{y}<br>(y = 0 - 15) | Specify the communications device number to be used by the sensor. |
| Callback function for FS3000 sensor device{x}<br>(x = 0 or 1) | fs3000_user_callback{x}<br>(x = 0 or 1) | Specify the name of the user callback function.<br>When "NULL" is specified, no callback function is used. |

### 5.1.3 RL78 Family

Select the **"r_fs3000"** component on the "Component" tabbed page of the Smart Configurator, and the configurable items will be shown in the "Configure" panel.

**Table 5-3 FS3000 Settings for RL78 Family**

| Configurable Item | Value | Description |
|---|---|---|
| Configurations | | |
| Parameter Checking | 0 | Specify the include parameter check processing in code.<br>When "Disabled" is specified, excluding in the code.<br>When "Enabled" is specified, including in the code. |
| | 1 | |
| Number of FS3000 sensors | 1 | Specify the number of FS3000 sensors. |
| | 2 | |
| Device type of FS3000 Sensors | FS3000-1005 | Specify the type of sensor.<br>"FS3000-1005" only can be selected. |
| | FS3000-1015 | |
| Using communication line number for FS3000 sensor device{x}<br>(x = 0 or 1) | Comms{y}<br>(y = 0 - 4) | Specify the device number for COMMS_I2C. |
| Callback function for FS3000 sensor device{x}<br>(x = 0 or 1) | fs3000_user_callback{x}<br>(x = 0 or 1) | Specify the name of the user callback function.<br>When "NULL" is specified, no callback function is used. |

## 5.2 I2C Communication Middleware (COMMS_I2C) Settings

### 5.2.1 RA Family

Select the **“rm_comms_i2c”** stack in the "Stack" tabbed page of the FSP Configurator, and the configurable items are shown in the "Properties" tabbed page.

**Table 5-4 COMMS_I2C Settings for RA Family**

| Configurable Item | Value | Description |
|---|---|---|
| Common | | |
| Parameter Checking | Default (BSP)<br>Enabled<br>Disabled | Specify the include parameter check processing in code.<br>When “Disabled” is specified, excluding in the code.<br>When “Enabled” is specified, including in the code. |
| Module g_comms_i2c_device0 I2C Communication Device (rm_comms_i2c) | | |
| Name | g_comms_i2c_device0 | Specify the name of the module. |
| Semaphore Timeout | 0xFFFFFFFF | For an RTOS project, specify the time of semaphore timeout. |
| Slave Address | 0x28 | Specify the slave address.<br>No setting is required as this will be overwritten by the Sensor Control module. |
| Address Mode | 7-Bit | Specify the number of slave address bits.<br>No setting is required as this will be overwritten by the Sensor Control module. |
| Callback | rm_fs3000_comms_i2c_callback | Specify the name of the user callback function.<br>No setting is required as this will be overwritten by the Sensor Control module. |
| Module g_comms_i2c_bus0 I2C Shared Bus (rm_comms_i2c) | | |
| Name | g_comms_i2c_bus0 | Specify the name of the I2C module. |
| Bus Timeout | 0xFFFFFFFF | Specify the time of I2C bus timeout. |
| Semaphore for blocking | Unuse<br>Use | For an RTOS project, enable or disable the blocking processing. |
| Recursive Mutex for Bus | Unuse<br>Use | For an RTOS project, enable or disable the recursive operation when blocking processing is enabled. |
| Channel | 0 | Specify the channel number to be used.<br>This setting is valid only when the I2C driver is “r_iic_master”.<br>When using other I2C drivers, this setting is invalid. |
| Rate | Standard<br>Fast-mode<br>Fast-mode plus | Specify the bit rate.<br>This setting is valid only when the I2C driver is “r_iic_master”.<br>When using FS3000, Standard or Fast-mode can be set. If other devices are connected on the same bus, set the transfer rate taking into consideration the transfer rate that can be set for those devices.<br>When using other I2C drivers, this setting is invalid. |

### 5.2.2 RX Family

Select the **"r_comms_i2c_rx"** component in the "Component" tabbed page of the Smart Configurator, and the configurable items are shown in the "Configure" panel.

**Table 5-5 COMMS_I2C Settings for RX Family**

| Configurable Item | Value | Description |
|---|---|---|
| Configurations | | |
| Parameter Checking | System Default<br>Enabled<br>Disabled | Specify the include parameter check processing in code.<br>When "Disabled" is specified, excluding in the code.<br>When "Enabled" is specified, including in the code. |
| Number of I2C Shared Buses | Unused<br>1<br>2 - 16 | Specify the number of communications bus lines that can be connected. |
| Number of I2C Communication Devices | Unused<br>1<br>2 - 16 | Specify the number of I2C device that can be connected. |
| Blocking operation supporting with RTOS | Disabled<br>Enabled | For an RTOS project, enable or disable the blocking operation. |
| Bus lock operation supporting with RTOS | Disabled<br>Enabled | For an RTOS project, enable or disable the bus lock operation. |
| I2C Driver Type for I2C Shared bus{x}<br>(x = 0 - 15) | RIIC<br>SCI IIC<br>Not selected | Specify the I2C bus type to be used for the communication bus.<br>When using the "RIIC", r_riic_rx is necessary. When using the "SCI IIC", "r_sci_iic_rx is necessary.<br>If an unused FIT module is deleted, a warning message will appear, but this does not affect the operation. |
| Channel No. for I2C Shared bus{x}<br>(x = 0 - 15) | 0 | Specify the I2C channel number to be used for the communication bus. |
| Timeout for the bus lock of I2C Shared Bus{x}<br>(x = 0 - 15) | 0xFFFFFFFF | Specify the time of I2C bus lock timeout. |
| I2C Shared Bus No. for I2C Communication Device{x}<br>(x = 0 - 15) | I2C Shared Bus{x}<br>(x = 0 - 15) | Specify the configuration of used communication bus. |
| Slave address for I2C Communication device{x}<br>(x = 0 - 15) | 0x00 | Specify the slave address of the device to be connected to the communications bus.<br>When using FS3000, specify 0x38. |
| Address mode for I2C Communication device{x}<br>(x = 0 - 15) | 7 bit address mode | Specify the slave address mode.<br>When using FS3000, specify the 7-bit address mode. |
| Callback function for I2C Communication device{x}<br>(x = 0 - 15) | comms_i2c_user_callback{x}<br>(x = 0 - 15) | Specify the name of the user callback function.<br>When using r_fs3000_rx, specify rm_ fs3000_callback{y} (y = 0 or 1). |
| Timeout for the blocking bus of I2C Communication device{x}<br>(x = 0 - 15) | 0xFFFFFFFF | Specify the time of I2C bus blocking timeout. |

### 5.2.3 RL78 Family

Select the **"r_comms_i2c"** component on the "Component" tabbed page of the Smart Configurator, and the configurable items will be shown in the "Configure" panel.

**Table 5-6 COMMS_I2C Settings for RL78 Family**

| Configurable Item | Value | Description |
|---|---|---|
| Configurations | | |
| Parameter Checking | System Default<br>Enabled<br>Disabled | Specify the include parameter check processing in code.<br>When "Disabled" is specified, excluding in the code.<br>When "Enabled" is specified, including in the code. |
| Number of I2C Shared Buses | Unused<br>1<br>2 - 5 | Specify the number of communication bus lines that can be connected. |
| Number of I2C communication Devices | Unused<br>1<br>2 - 5 | Specify the number of I2C devices can be connected. |
| I2C Driver Type for I2C Shared bus{x}<br>(x = 0 - 4) | IICA<br>SAU IIC<br>Not selected | Specify the I2C type to be used for the communication bus.<br>When using FS3000, specify "IICA". |
| Component name for the I2C bus{x} | Config_IIC00 | Specify the I2C bus component name to be used for the communication bus. |
| I2C Shared Bus No. for I2C Communication Device{x}<br>(x = 0 - 4) | I2C bus0<br>I2C bus1<br>I2C bus2<br>I2C bus3<br>I2C bus4 | Specify the I2C bus configuration to be used for the communication bus. |
| Slave address for I2C Communication device{x}<br>(x = 0 - 4) | 0x00 | Specify the slave address of the device to be connected to the communications bus.<br>When using FS3000, specify 0x28. |
| Callback function for I2C Communication device{x}<br>(x = 0 - 4) | comms_i2c_user_callback{x}<br>(x = 0 - 4) | Specify the name of the user callback function.<br>When using r_fs3000_rx, specify rm_ fs3000_callback{y} (y = 0 or 1). |

## 5.3 I2C Driver Settings

### 5.3.1 RA Family

Select the **“r_iic_master”**, **“r_sci_i2c”** or **“r_iica_master”** stack in the "Stack" tabbed page of the FSP Configurator, and the configurable items are shown in the "Properties" tabbed page.

**Simplified I2C using Serial Array Unit (SAU) cannot be used because the clock stretch function is not supported.**

**(1) r_iic_master**

**Table 5-7 r_iic_master Settings for RA Family**

| Configurable Item | Value | Description |
|---|---|---|
| Common | | |
| Parameter Checking | Default (BSP)<br>Enabled<br>Disabled | Specify the include parameter check processing in code.<br>When “Disabled” is specified, excluding in the code.<br>When “Enabled” is specified, including in the code. |
| DTC on Transmission and Reception | Enabled<br>Disabled | Specify whether to use the DTC for transmission and reception. |
| 10-bit slave addressing | Enabled<br>Disabled | Specify whether to support 10-bit addressing for the slave address.<br>No setting is required as this will be overwritten by COMMS_I2C. |
| Module g_i2c_master0 I2C Master (r_iic_master) | | |
| Name | g_i2c_master0 | Specify the name of the module. |
| Channel | 0 | Specify the channel number to be used.<br>No setting is required as this will be overwritten by COMMS_I2C. |
| Rate | Standard<br>Fast-mode<br>Fast-mode plus | Specify the bit rate.<br>No setting is required as this will be overwritten by COMMS_I2C. |
| Custom Rate (bps) | 0 | Specify the custom bit rate.<br>This setting is valid when the value is other than 0. Use this setting when you want to set the low bitrate within the “Rate” setting range. |
| Rise Time (ns) | 120 | Specify the SCL rise time according to the specifications of the target board to be used. |
| Fall Time (ns) | 120 | Specify the SCL fall time according to the specifications of the target board to be used. |
| Duty Cycle (%) | 50 | Specify the SCL duty cycle. |
| Slave Address | 0x00 | Specify the slave address for the device to be connected.<br>No setting is required as this will be overwritten by COMMS_I2C. |
| Address Mode | 7-Bit<br>10-Bit | Specify the salve address mode for the device to be connected.<br>No setting is required as this will be overwritten by COMMS_I2C. |
| Timeout Mode | Short Mode<br>Long Mode | Specify the time of I2C bus timeout. |
| Timeout during SCL low | Enabled<br>Disabled | Specify whether to timeout can occur when SCL is held low for a duration longer than what is set in the timeout mode. |
| Callback | rm_comms_i2c_callback | Set the user callback function name.<br>No setting is required as this will be overwritten by COMMS_I2C. |
| Interrupt Priority Level | Priority 0 (highest)<br>Priority 1<br>Priority 2<br>Priority 3 | Specify the interrupt priority level of the I2C bus driver. |
| Pins | | |
| SDA | Pxxx | The pin numbers to be used by the driver are displayed.<br>Use the "Pins" tabbed page to modify the pin configuration. |
| SCL | Pxxx | |

### (2) r_sci_i2c

**Table 5-8 r_sci_i2c Settings for RA Family**

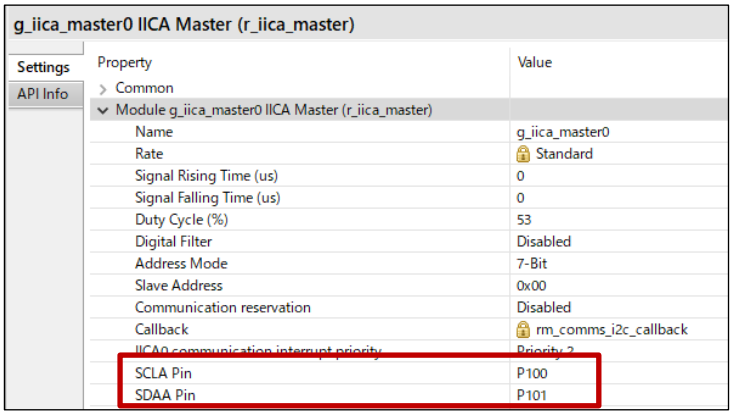
| Configurable Item | Value | Description |
|---|---|---|
| Common | | |
| Parameter Checking | Default (BSP) | Specify the include parameter check processing in code.<br>When “Disabled” is specified, excluding in the code.<br>When “Enabled” is specified, including in the code. |
| | Enabled | |
| | Disabled | |
| DTC on Transmission and Reception | Enabled | Specify whether to use the DTC for transmission and reception. |
| | Disabled | |
| 10-bit slave addressing | Enabled | Specify whether to support 10-bit addressing for the slave address.<br>No setting is required as this will be overwritten by COMMS_I2C. |
| | Disabled | |
| Module g_i2c0 I2C Master (r_sci_i2c) | | |
| Name | g_i2c0 | Specify the name of the module. |
| Channel | 0 | Specify the channel number to be used. |
| Slave Address | 0x00 | Specify the slave address for the device to be connected.<br>No setting is required as this will be overwritten by COMMS_I2C. |
| Address Mode | 7-Bit | Specify the salve address mode for the device to be connected.<br>No setting is required as this will be overwritten by COMMS_I2C. |
| | 10-bit | |
| Rate | Standard | Specify the bit rate.<br>When using FS3000, Standard or Fast-mode can be set. If other devices are connected on the same bus, set the transfer rate taking into consideration the transfer rate that can be set for those devices. |
| | Fast-mode | |
| Custom Rate (bps) | 0 | Specify the custom bit rate.<br>This setting is valid when the value is other than 0. Use this setting when you want to set the low bitrate within the “Rate” setting range. |
| SDA Output Delay (nano seconds) | 300 | Specify the SDA output delay time. |
| Noise filter setting | Use clock signal divided by 1 with noise filter | Specify the noise filter to be used for input signals. |
| | Use clock signal divided by 2 with noise filter | |
| | Use clock signal divided by 4 with noise filter | |
| | Use clock signal divided by 8 with noise filter | |
| Bit Rate Modulation | Enable | Enable or disable the bit rate modulation function. |
| | Disable | |
| Callback | rm_comms_i2c_callback | Set the user callback function name.<br>No setting is required as this will be overwritten by COMMS_I2C. |
| Interrupt Priority Level | Priority 0 (highest) | Specify the interrupt priority level of the I2C bus driver. |
| | Priority 1 | |
| | Priority 2 | |
| | Priority 3 | |
| RX Interrupt Priority Level [Only used when DTC is enabled] | Priority 0 (highest) | When using the DTC, specify the priority level of the reception interrupt. |
| | Priority 1 | |
| | Priority 2 | |
| | Priority 3 | |
| | Disabled | |
| Pins | | |
| SDA | Pxxx | The pin numbers to be used by the driver are displayed.<br>Use the "Pins" tabbed page to modify the pin configuration. |
| SCL | Pxxx | |

### (3) r_iica_master

**When configuring IICA using FSP v5.4.0 or higher, set “SCLA Pin” and “SDAA Pin” in “Stacks” tabbed page to Pin numbers only.**

**Table 5-9 r_iica_master Settings for RA Family**

| Configurable Item | Value | Description |
|---|---|---|
| Common | | |
| Parameter Checking | Default (BSP)<br>Enabled<br>Disabled | Specify the include parameter check processing in code.<br>When “Disabled” is specified, excluding in the code.<br>When “Enabled” is specified, including in the code. |
| 10-bit slave addressing | Enabled<br>Disabled | Specify whether to support 10-bit addressing for the slave address.<br>No setting is required as this will be overwritten by COMMS_I2C. |
| Module g_iica_master0 IICA Master (r_iica_master) | | |
| Name | g_iica_master0 | Specify the name of the module. |
| Rate | Standard<br>Fast-mode<br>Fast-mode plus | Specify the bit rate.<br>Specify “Standard” due to the electrical characteristics of IICAx.<br>(For FS3000, it is possible to set to “Standard” or “Fast-mode”.) |
| Custom Rate (bps) | 0 | Specify the custom bit rate.<br>This setting is valid when the value is other than 0. Use this setting when you want to set the low bitrate within the “Rate” setting range. |
| Signal Rising Times (us) | 0 | Specify the SCL rise time according to the specifications of the target board to be used. |
| Signal Falling Times (us) | 0 | Specify the SCL fall time according to the specifications of the target board to be used. |
| Duty Cycle (%) | 53 | Specify the SCL duty cycle. |
| Digital Filter | Enabled<br>Disabled | Specify whether to use the digital filter. |
| Address Mode | 7-Bit<br>10-Bit | Specify the salve address mode for the device to be connected.<br>No setting is required as this will be overwritten by COMMS_I2C. |
| Slave Address | 0x00 | Specify the slave address for the device to be connected.<br>No setting is required as this will be overwritten by COMMS_I2C. |
| Communication reservation | Enabled<br>Disabled | Specify whether to use the communication reservation. |
| Callback | rm_comms_i2c_callback | Set the user callback function name.<br>No setting is required as this will be overwritten by COMMS_I2C. |
| IICA0 communication interrupt priority | Priority 0 (highest)<br>Priority 1<br>Priority 2<br>Priority 3 | Specify the interrupt priority level of the I2C bus driver. |
| SCLA Pin | Pxxx | Specify the pin numbers to be used.<br>No setting is required in “Pins” tabbed page. |
| SDAA Pin | Pxxx | |



### 5.3.2 RX Family

Select the **"r_riic_rx"** or **"r_sci_iic_rx"** component in the "Component" tabbed page of the Smart Configurator, and the configurable items are shown in the "Configure" panel.

**(1) r_riic_rx**

**Table 5-10 r_riic_rx Settings for RX Family**

| Configurable Item | Value | Description |
|---|---|---|
| Configurations | | |
| Set parameter checking enable | System Default | Specify the include parameter check processing in code.<br>When "Not" is specified, excluding in the code.<br>When "Include" is specified, including in the code. |
| | Not | |
| | Include | |
| MCU supported channels for CH{x}<br>(x = 0 - 2) | Not supported | Specify whether to support the operation of channel. |
| | Supported | |
| CH{x} RIIC bps(kbps)<br>(x = 0 - 2) | 400 | Specify the bit rate.<br>When using FS3000, set it to 400kbps or less. If other devices are connected on the same bus, set the transfer rate taking into consideration the transfer rate that can be set for those devices. |
| Digital filter for CH{x}<br>(x = 0 - 2) | Not | Specify the digital filter for input signals. |
| | One IIC phi | |
| | Two IIC phi | |
| | Three IIC phi | |
| | Four IIC phi | |
| Setting port setting processing | Not include port setting | Specify whether to include the pin function settings in the code to be generated. |
| | Include port setting | |
| Master arbitration lost detection function for CH{x}<br>(x = 0 - 2) | Unused | Specify whether to use the master arbitration lost detection function. |
| | Used | |
| Address {y} format for CH{x}<br>(x = 0 - 2, y = 0 - 2) | Not | Specify whether to support 7-bit addressing or 10-bit addressing for the slave address.<br>When using FS3000, select "7 bit address format".<br>Do not connect devices with different address formats on the same bus. |
| | 7 bit address format | |
| | 10 bit address format | |
| Slave Address {y} for CH{x}<br>(x = 0 - 2, y = 0 - 2) | 0x0025 | Specify the slave address of the designated device.<br>No setting is required as this will be overwritten by COMMS_I2C. |
| General call address for CH{x} | Unused | Specify whether to use the general call function. |
| | Used | |
| CH{x} RXI INT Priority Level<br>(x = 0 - 2) | Level 1 | Specify the priority level of the reception interrupt. |
| | Level 2 | |
| | … | |
| | Level 14 | |
| | Level 15 (highest) | |
| CH{x} TXI INT Priority Level<br>(x = 0 - 2) | Level 1 | Specify the priority level of the transmission interrupt. |
| | Level 2 | |
| | … | |
| | Level 14 | |
| | Level 15 (highest) | |

| | | |
|---|---|---|
| CH{x} EEI INT Priority Level<br>(x = 0 - 2) | Level 1 | Specify the priority level of the error interrupt. |
| | Level 2 | |
| | … | |
| | Level 14 | |
| | Level 15 (highest) | |
| CH{x} TEI INT Priority Level<br>(x = 0 - 2) | Level 1 | Specify the priority level of the transmission end interrupt. |
| | Level 2 | |
| | … | |
| | Level 14 | |
| | Level 15 (highest) | |
| Timeout function for CH{x}<br>(x = 0 - 2) | Unused | Specify whether to use the timeout function. |
| | Used | |
| Timeout detection time for CH{x}<br>(x = 0 - 2) | Long mode | Specify the time for timeout detection. |
| | Short mode | |
| Count up during low period of timeout detection for CH{x}<br>(x = 0 - 2) | Unused | Specify whether to increment the counter for detecting a timeout while SCL is at the low level. |
| | Used | |
| Count up during high period of timeout detection for CH{x}<br>(x = 0 - 2) | Unused | Specify whether to increment the counter for detecting a timeout while SCL is at the high level. |
| | Used | |
| Set Counter of checking bus busy | 1000 | Specify the counter value to be judged to represent the bus busy state. |
| Resources | | |
| SCLx Pins | Checked | Specify the pins to be used.<br>Select the checkboxes for the desired pins. |
| | Unchecked | |
| SDAx Pins | Checked | |
| | Unchecked | |

### (2) r_sci_iic_rx

**Table 5-11 r_sci_iic_rx Settings for RX Family**

| Configurable Item | Value | Description |
|---|---|---|
| Configurations | | |
| Set parameter checking enable | System Default | Specify the include parameter check processing in code.<br>When “Not” is specified, excluding in the code.<br>When “Include” is specified, including in the code. |
| | Not | |
| | Include | |
| MCU supported channels for CH{x} (x = 0 - 12) | Not supported | Specify whether to support the operation of channel. |
| | Supported | |
| SCI IIC bitrate (bps) for CH{x} (x = 0 - 12) | 384000 | Specify the bit rate.<br>When using FS3000, set it to 38400bps or less. If other devices are connected on the same bus, set the transfer rate taking into consideration the transfer rate that can be set for those devices. |
| Interrupt Priority for CH{x} (x = 0 - 12) | Level 1 | Specify the interrupt priority level. |
| | Level 2 | |
| | … | |
| | Level 14 | |
| | Level 15 (highest) | |
| Digital noise filter (NFEN bit) for CH{x} (x = 0 - 12) | Disable | Specify whether to use the digital noise filter. |
| | Enable | |
| Noise Filter Setting Register (NFCS bit) for CH{x} (x = 0 - 12) | The clock divided by 1 | Specify the function of the digital noise filter. |
| | The clock divided by 2 | |
| | The clock divided by 4 | |
| | The clock divided by 8 | |
| I2C Mode Register 1 (IICDL bit) for CH{x} (x = 0 - 12) | 18 | Specify the number of SDA output delay cycles.<br>Set in the range of 1 to 31. |
| Software bus busy check counter | 1000 | Specify the counter value to be judged to represent the bus busy state. |
| Port Setting Processing | Not include port setting | Specify whether to include the pin function settings in the code to be generated. |
| | Include port setting | |
| Resources | | |
| SSCLx Pins | Checked | Specify the pins to be used.<br>Select the checkboxes for the desired pins. |
| | Unchecked | |
| SSDAx Pins | Checked | |
| | Unchecked | |

### 5.3.3 RL78 Family

Select **"IICAx"** as resource the IIC Communication (Master mode) component in the Smart Configurator, and the configurable items will be shown in the “Configure” panel.

**Simplified I2C using Serial Array Unit (SAU) cannot be used because the clock stretch function is not supported.**

**(1) IICAx**

**Table 5-12 Serial Settings for RL78 Family**

| Configurable Item | Value | Description |
|---|---|---|
| Configurations | | |
| Clock mode setting | fCLK | Specify the clock to drive counting. |
| | fCLK/2 | |
| Address | 16 | Specify the local address. |
| Operation mode setting | Standard | Specify the operating mode.<br>When using FS3000, Standard or Fast-mode can be set. If other devices are connected on the same bus, set the transfer rate taking into consideration the transfer rate that can be set for those devices. |
| | Fast mode | |
| | Fast mode plus | |
| Digital filter on | Checked | Specify whether to use the digital filtering. |
| | Unchecked | |
| Transfer clock (fSCL) | 100000 | Specify the bit rate.<br>Due to the electrical characteristics of IICAx, specify 100000bps or less. |
| Set tR and tF manually | Checked | Manually set the SDAAn and SCLAn signal rising / falling times. |
| | Unchecked | |
| tR | 0 | Specify the SDAAn and SCLAn signal rising times. |
| tF | 0 | Specify the SDAAn and SCLAn signal falling times. |
| Communication end interrupt priority (INTIICAx) | Level0 (high) | Specify the priority level of the communication end interrupt. |
| | Level1 | |
| | Level2 | |
| | Level3 (low) | |
| Master transmission end | Checked | Specify whether to use the callback function when master transmission ends. |
| | Unchecked | |
| Master reception end | Checked | Specify whether to use the callback function when master reception ends. |
| | Unchecked | |
| Master error | Checked | Specify whether to use the callback function when a communication error occurs. |
| | Unchecked | |
| Generated stop condition in master transmission / reception end callback function | Checked | Specify whether to generate a stop condition in the callback function.<br>Set to “Unchecked”. |
| | Unchecked | |

# 6. Guide for Changing a Target Device

Use the following procedures to change the target device to a new one and run a sample project on the new device.

Before switching to a new device, import the original sample project for the current device to the workspace.

## 6.1 RA Sample Project

Use the following procedures to modify a sample project.

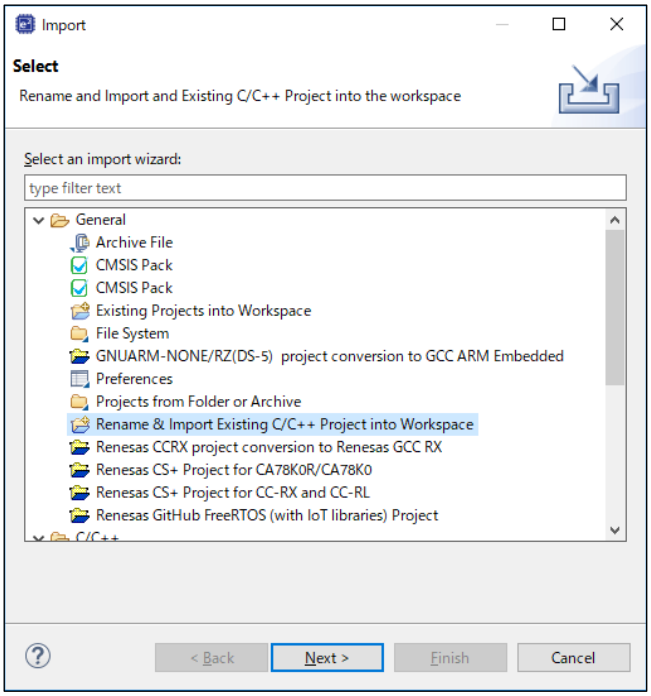
The following explains the change procedure for the following board change example. In addition, an Interposer Board is required when using a Pmod Type 2A/3A connector.

- Sample Project "FS3000_RA2E1_NonOS":
  PMOD1 (Type 2A/3A: SCI0)
  → PMOD1 (Option Type 6A: IIC1) or PMOD2 (Type 2A: SCI0) of the EK-RA6M4 board

### 6.1.1 Importing a Sample Project

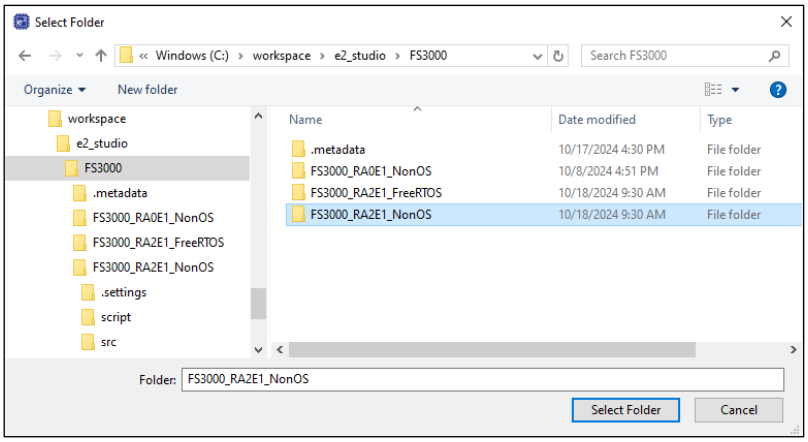
1. Select [Import] from the menu.

The "Import" window will appear. Select "Rename & Import Existing C/C++ Project into Workspace" in the window and press the [Next] button.

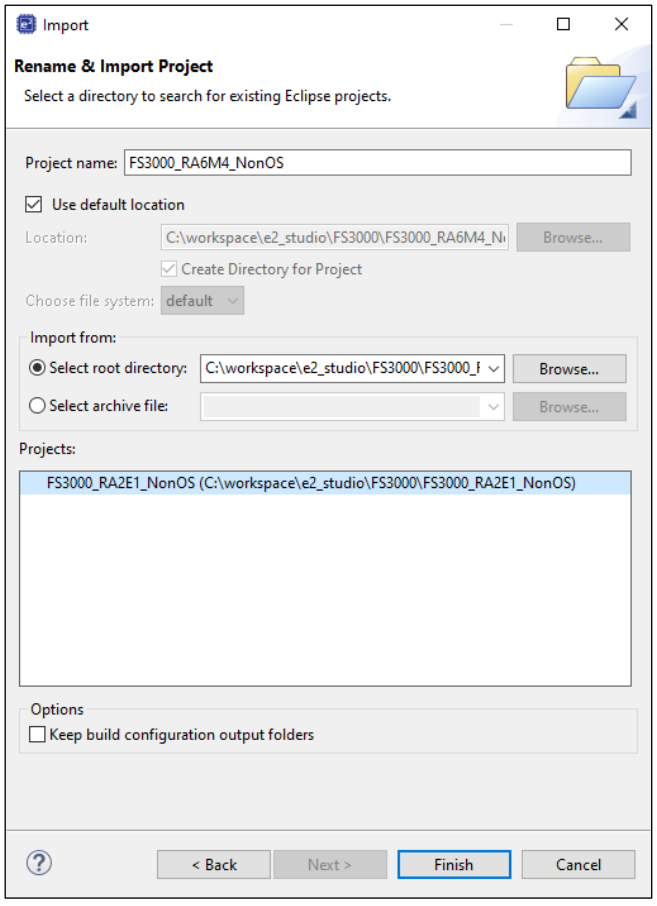


2. Press the [Browse] button to open the "Select Folder" window.

Select the folder of the original project for the current device from a list of imported sample projects and press the [Select Folder] button.




3. Enter the project name, select the original project for the current device, and press the [Finish] button.



### 6.1.2 Modifying Settings of FSP Configurator

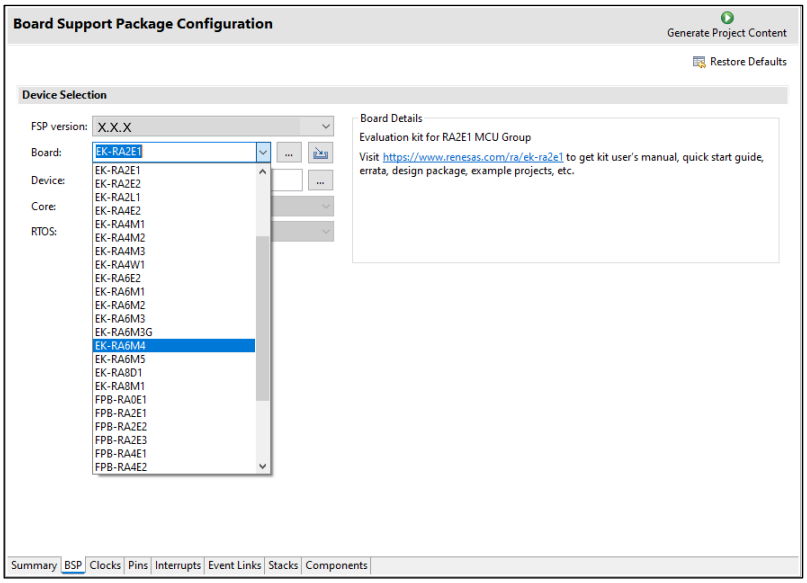
Double-click on "Configuratorn.xml" in the project tree to open the FSP Configurator.

#### (1) BSP

Change the settings of "Board" and "Device" in the "BSP" tabbed page.

When selecting a Renesas board, modify the "Board" setting only.

When selecting a board provided from other companies, change the "Board" setting to "Custom User Board (Any Device)" and then change the "Device" setting to the new device to be used.

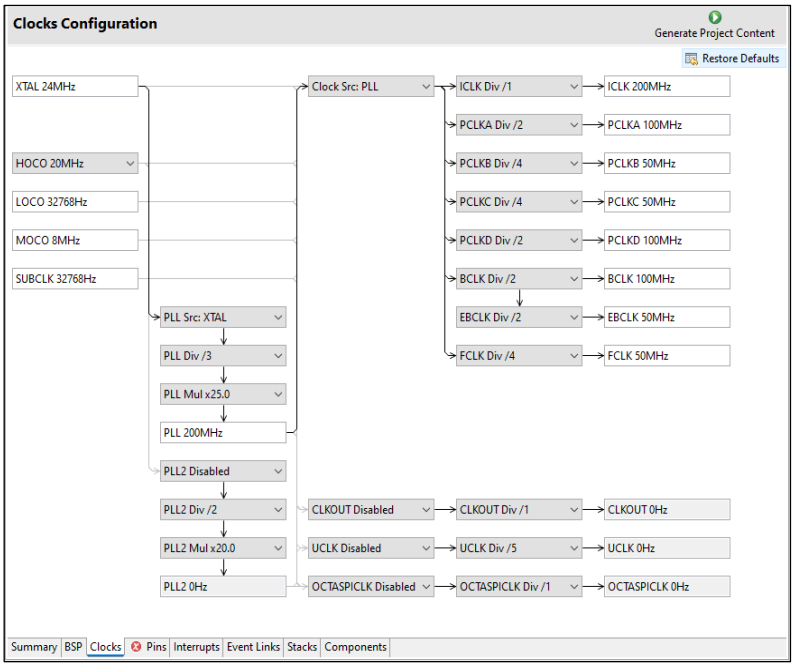



#### (2) Clocks

Set up the clocks in the "Clocks" tabbed page.

When "Custom User Board (Any Device)" is selected for "Board", set up the clocks according to the specifications of the target board to be used.

When a Renesas board is selected for "Board", the clocks are automatically set up.

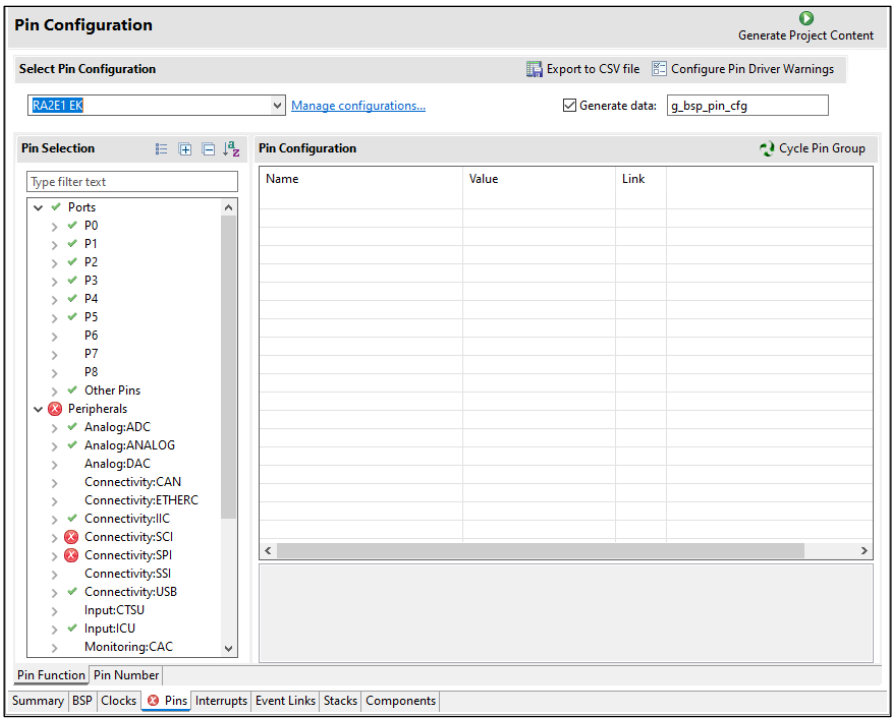


### (3) Pins

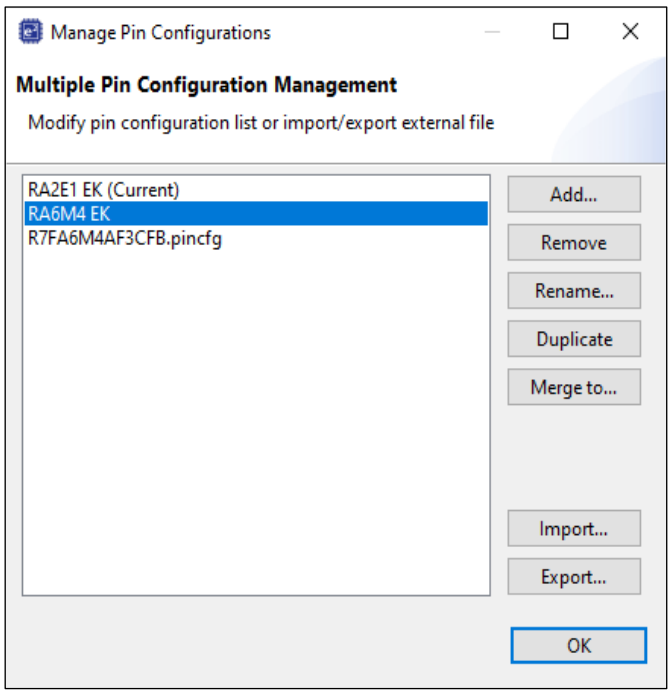
#### (a) Changing Board

In the “Pins” tabbed page, modify the pin configuration according to the specifications of the target board to be used.

When using a Renesas board, change the selection for "Select Pin Configuration" from ”RA2E1 EK” to the target board; appropriate pins are automatically assigned.




If the desired board is not displayed in the drop-down list for "Select Pin Configuration", click on [Manage Configuration] to open the "Manage Pin Configuration" window and select the desired board in the window.



### (b) Changing I2C I/F Pins

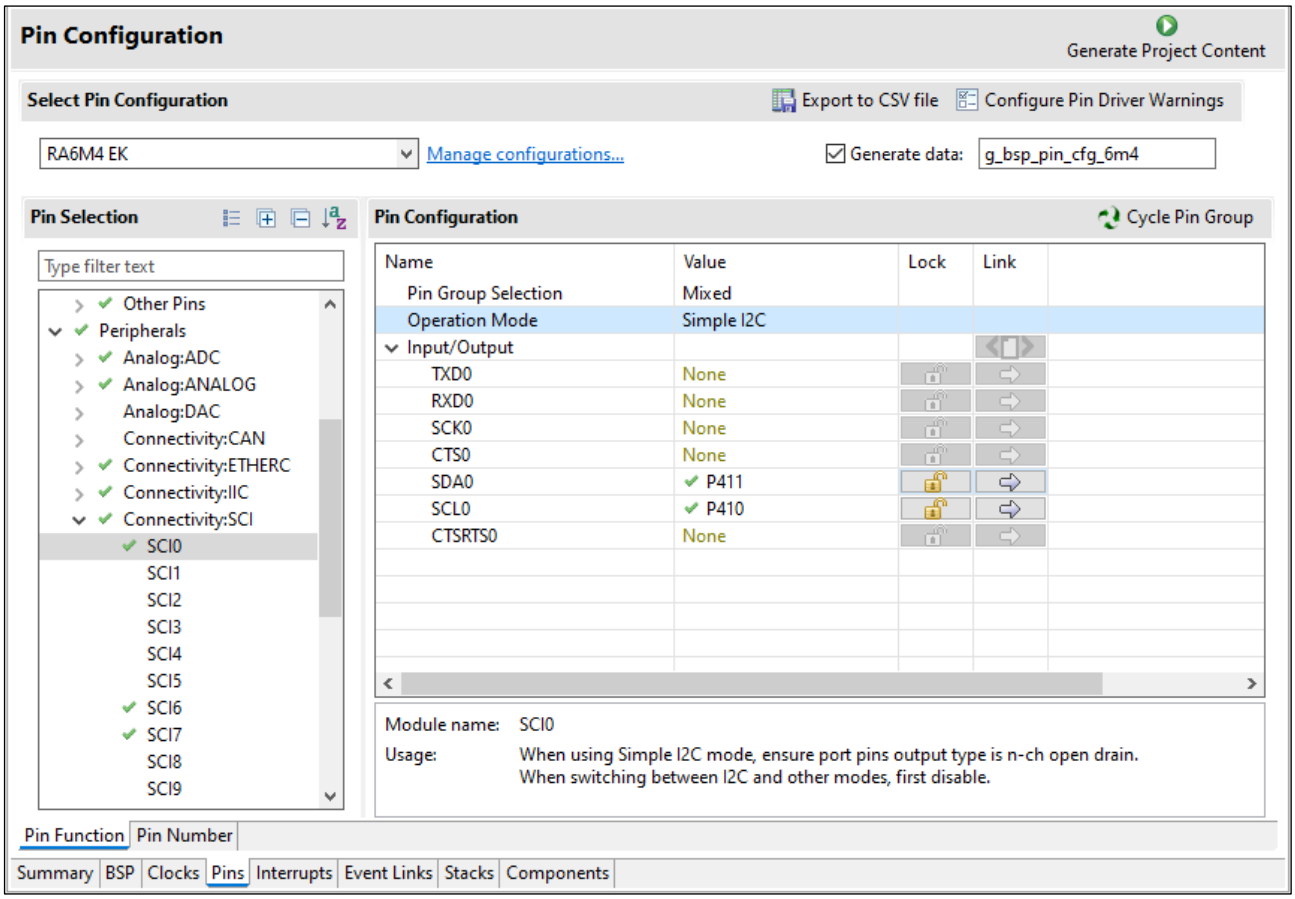
However, the "Select Pin Configuration" assignment will apply the SPI communication pin settings that support Pmod Type 2A on the EK-RA6M4 board.

This sample software uses Pmod Type 6A, therefore it is necessary to change the I2C communication pin settings that support Pmod Type 6A.

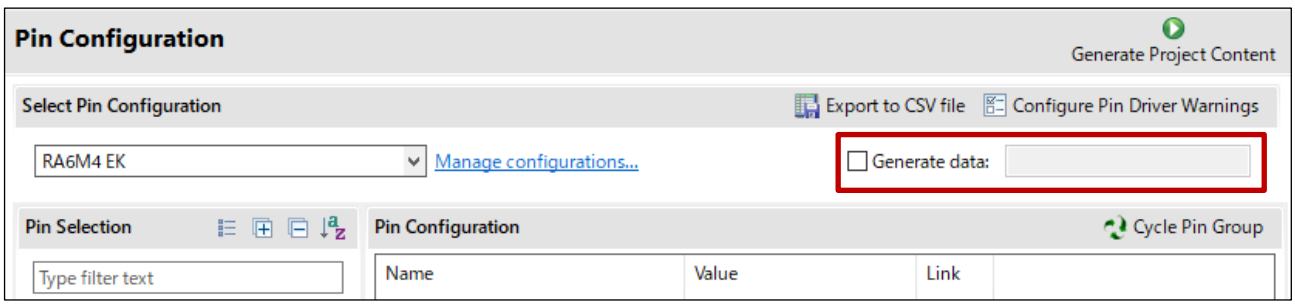
IIC1 is assigned to PMOD1 and SCI0 to PMOD2 on the EK-RA6M4 board.

I2C communication is assigned to P511 and P512 on PMOD1(Option Type 6A), and it is assigned to P410 and P411 on PMOD2.

After automatic assignment of "Select Pin Configuration", reconfigure in "Pin Configuration".



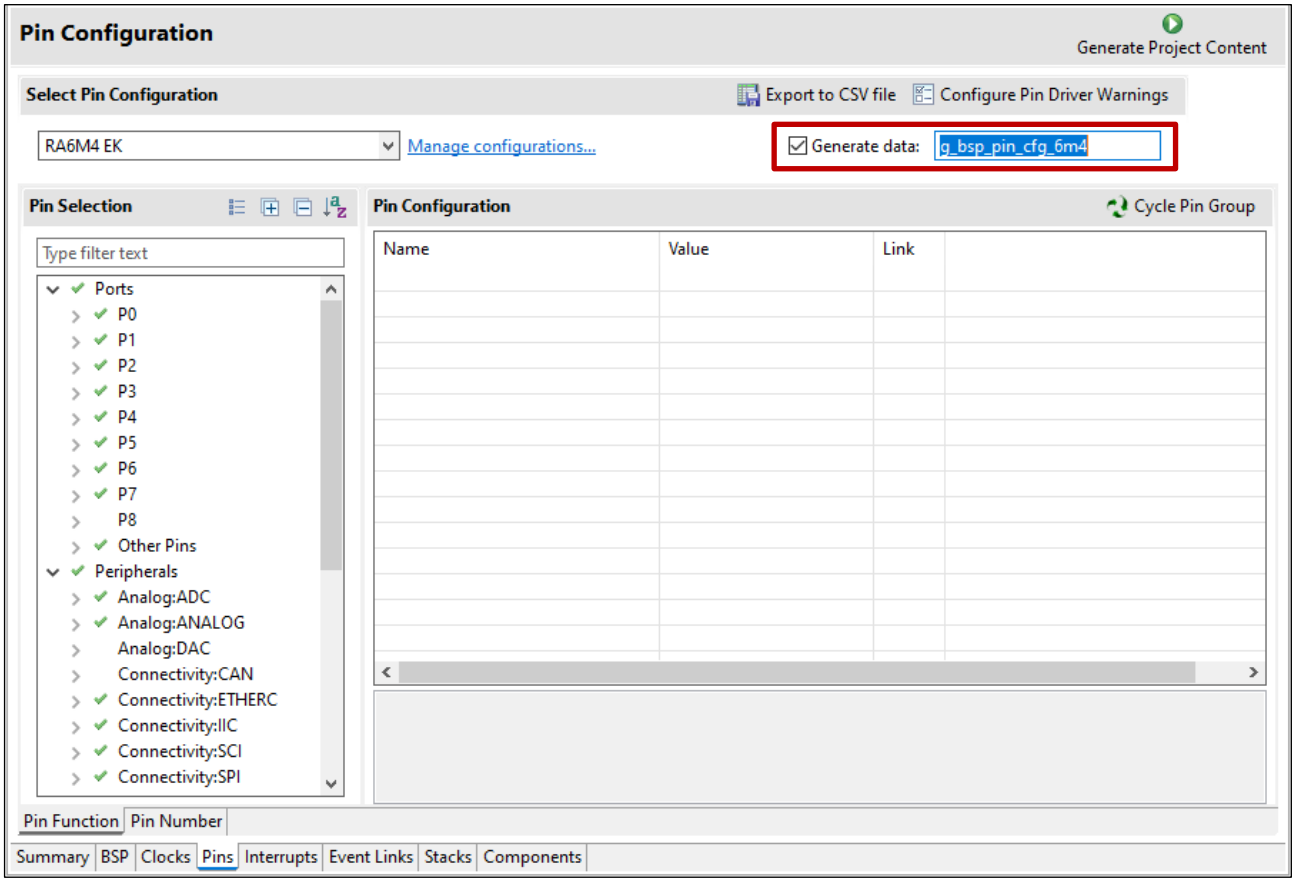

When you change the device, "Generate data" will be disabled. The next page explains how to enable it.



To enable generation of pin settings, check [Generate data] check-box and enter a desired name in the text field.

The entered name is linked to the pin configuration, therefore must use a unique name that does not duplicate with other pin configurations.

In our example, it is “g_bsp_pin_cfg_6m4”.



### (4) Stacks

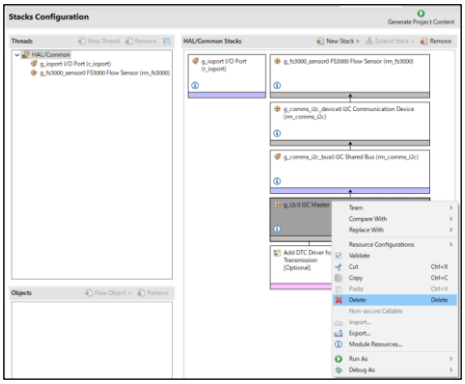
Modify the configuration of individual components in the "Stacks" tabbed page.

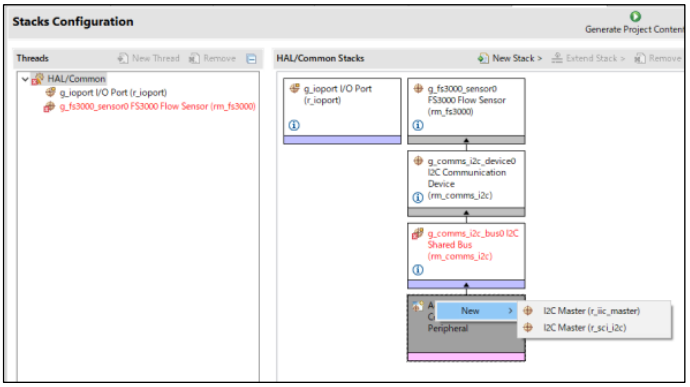
#### (a) Changing COMMS_I2C Setting and I2C Driver Settings

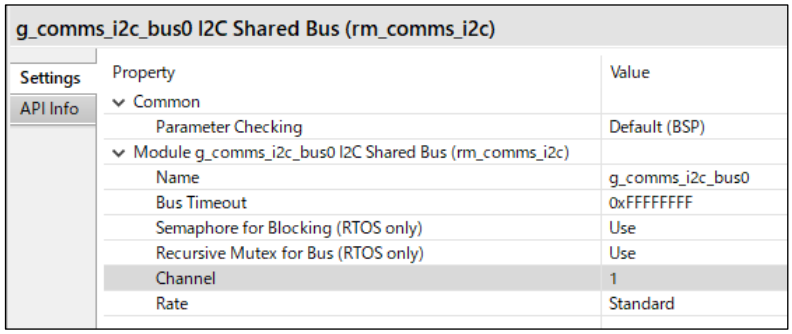
Modify the settings of COMMS_I2C and I2C driver according to the specifications of the target board. To use the pins of the I2C I/F, delete the unnecessary stack and add the new stack to use.

**Table 6-1 Settings of I2C I/F and Channel for EK-RA6M4**

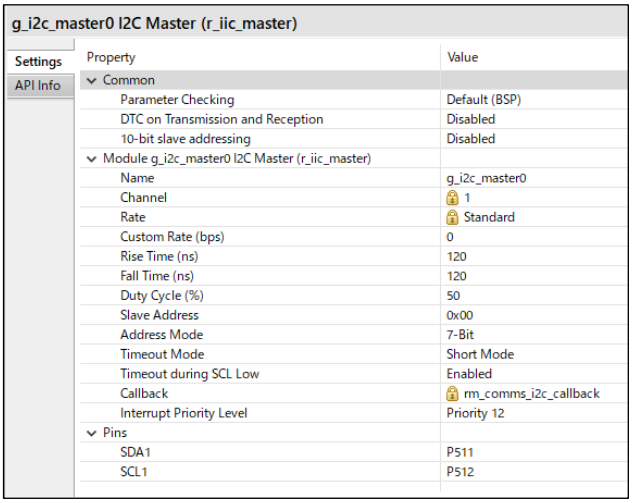
| EK-RA6M4 | I2C I/F | g_comms_i2c_bus0 I2C Shared Bus (rm_comms_i2c) | g_i2c_master0 I2C Master |
|---|---|---|---|
| PMOD1 Option Type 6A | IIC1 | Channel: 1 | Check Pins |
| PMOD2 Type 2A | SCI0 | Channel: 0 | Check Pins |






When setting IIC1

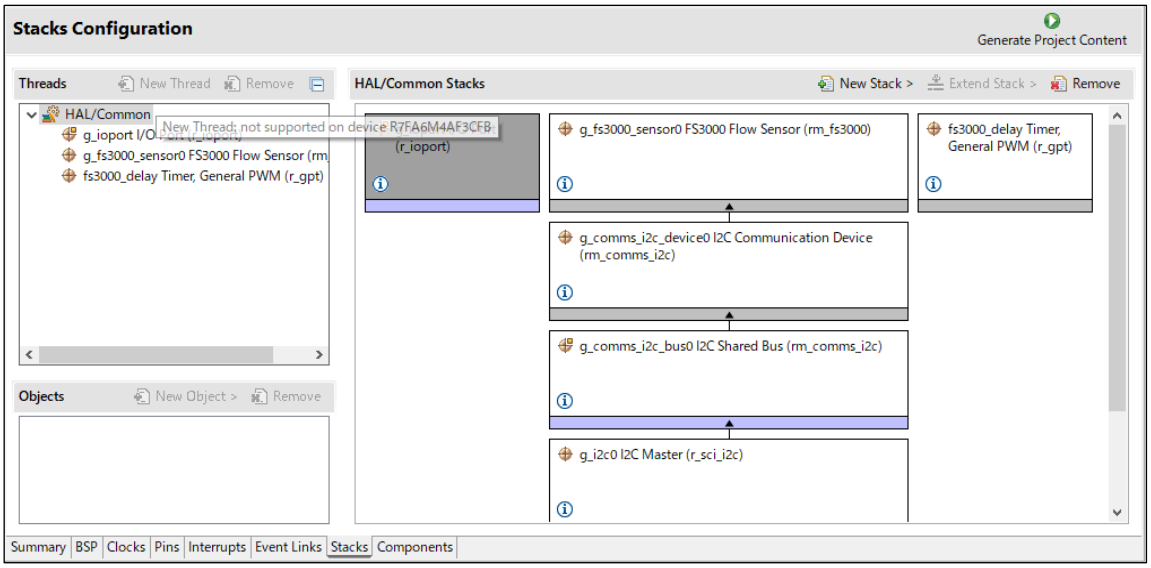


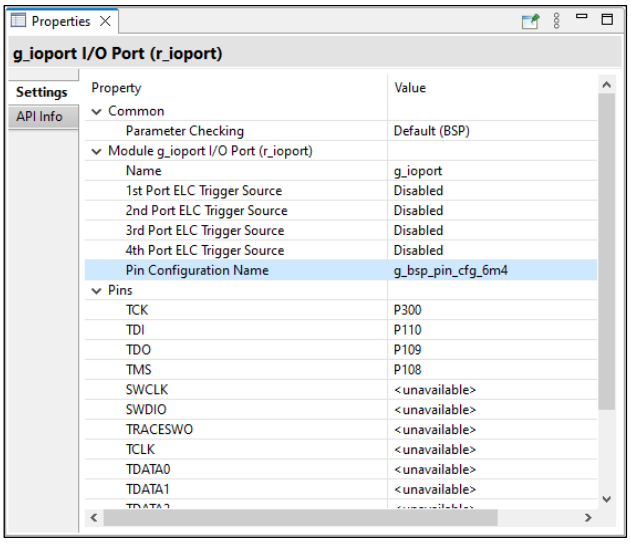

When setting IIC1

### (b) Changing General Purpose I/O Port Driver Settings

Enter the pin configuration name to use in "Pin Configuration Name" of "g_ioport I/O Port".

In our example, it is ”g_bsp_pin_cfg_6m4”.




If an error is displayed in other stacks, modify the specified item according to the error displayed.

### (5) Code Generation and Build

After modifications are finished, press [Generate Project Content] to generate files.

Build the project.

Select [Debug Configurations] from the menu and modify the debugger settings according to the specifications of the emulator to be connected to the target board.

## 6.1.3 Changing Toolchain Setting

If you want to use a toolchain other than the GCC ARM Embedded toolchain, copy RA_FS3000.c (Non-OS) or fs3000_sensor_thread_entry.c, sensor_thread_common.c, and sensor_thread_common.c (FreeRTOS) from this project to create a new project.

## 6.2 RX Sample Project

Use the following procedures to modify a sample project.

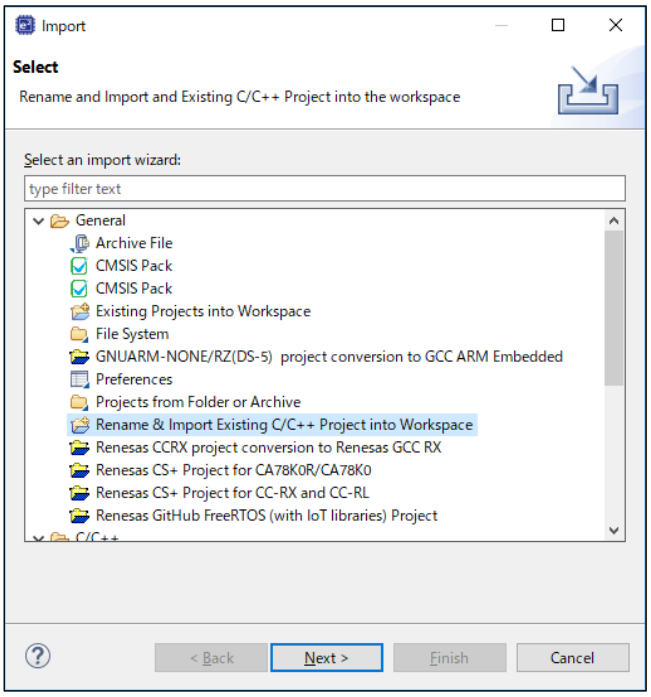
The following explains the change procedure for the following board change example. In addition, an Interposer Board is required when using a Pmod Type 2A/3A connector.

- Sample project "FS3000_RX65N_NonOS":
  PMOD1 (Type2A: SCI2)
  → PMOD1 (Type 2A: SCI8) of the RSK-RX231 board

### 6.2.1 Importing a Sample Project

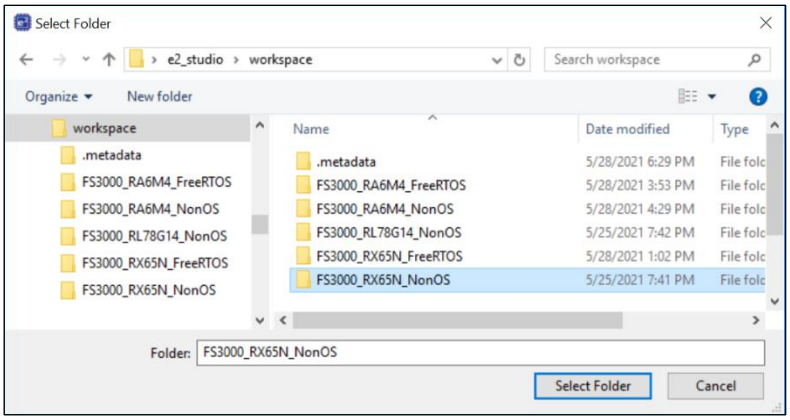
1. Select [Import] from the menu.

The "Import" window will appear. Select "Rename & Import Existing C/C++ Project into Workspace" in the window and press the [Next] button.

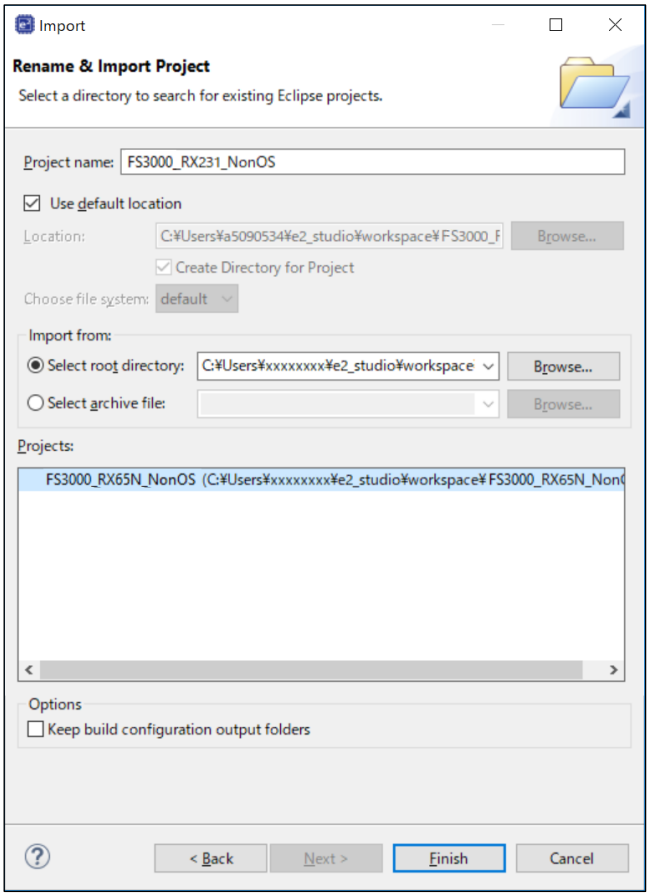



2. Press the [Browse] button to open the "Select Folder" window.

Select the folder of the original project for the current device from a list of imported sample projects and press the [Select Folder] button.

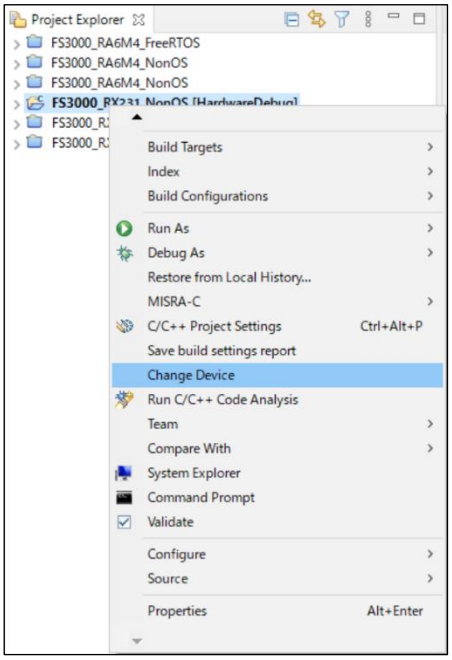


3. Enter the project name, select the original project for the current device, and press the [Finish] button.

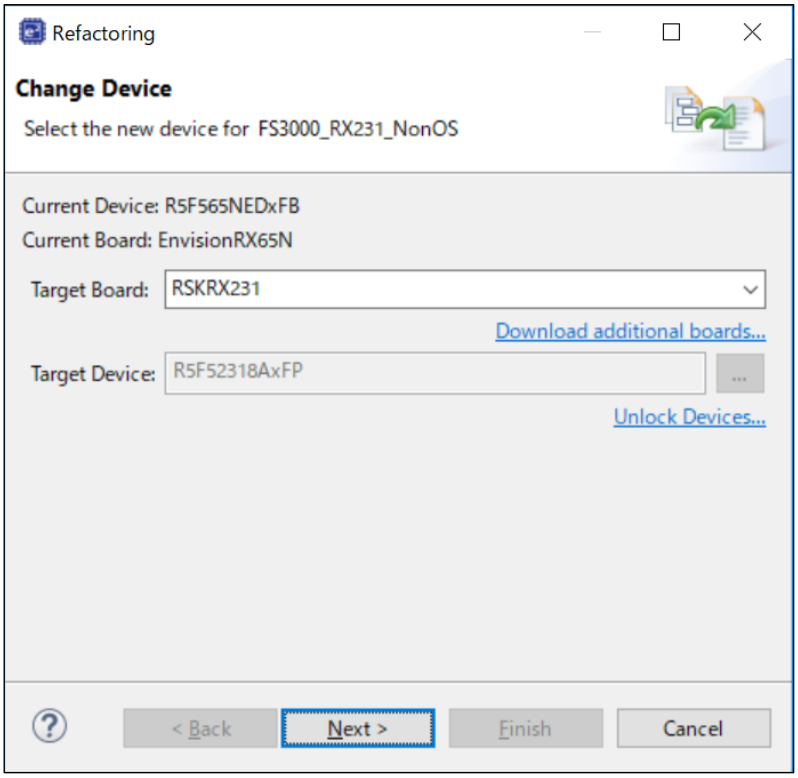


### 6.2.2 Changing a Device

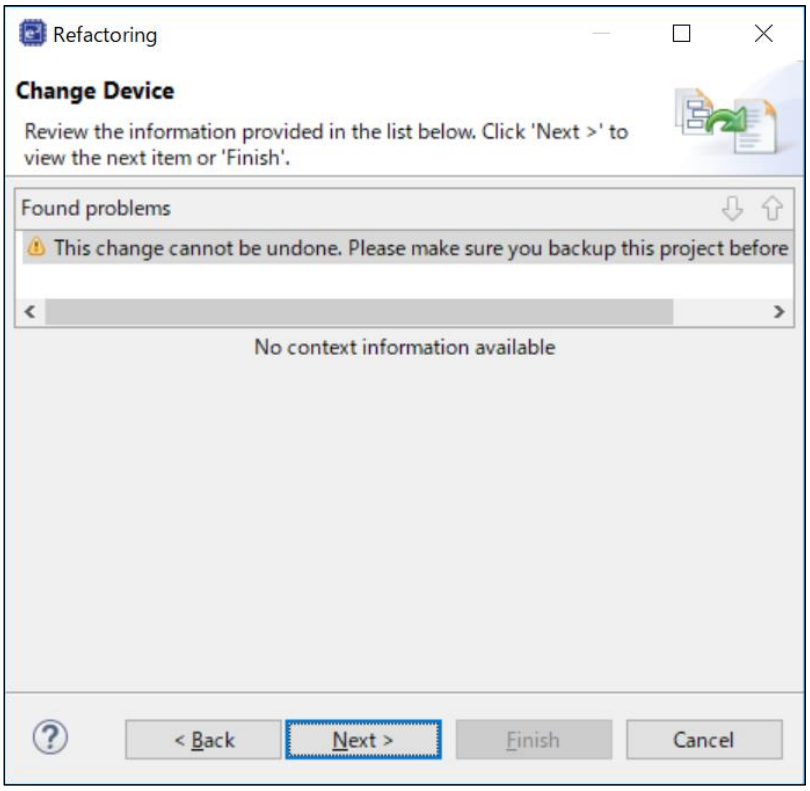
1. Select the imported project from the project tree and right-click on int to open the context menu. Select "Change Device" from the menu.



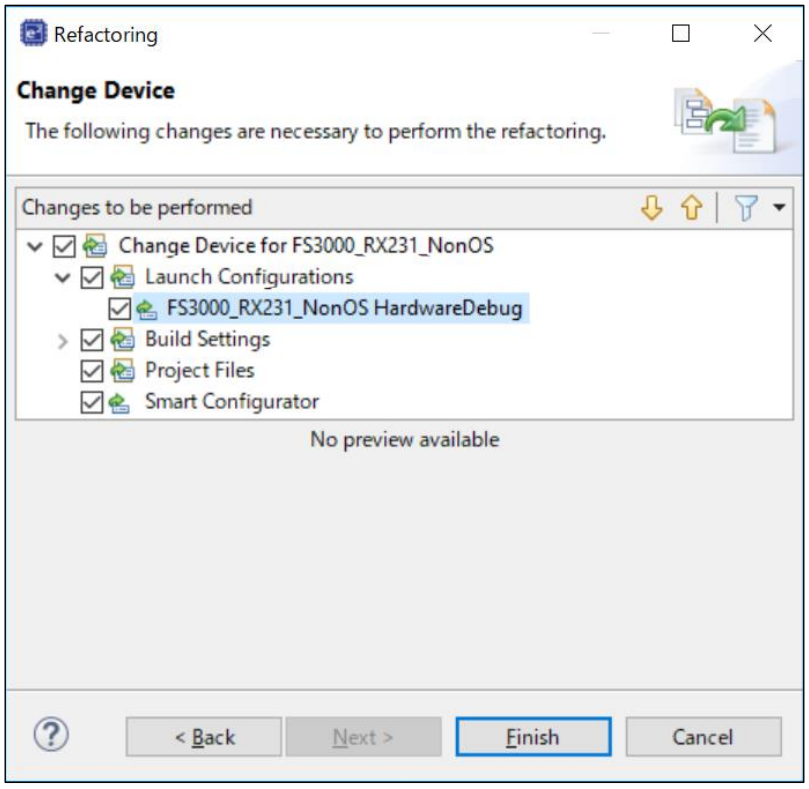

2. Select a desired board or device in the "Change Device" window and press the [Next] button.



3. If a warning message appears, read it and check if there is a problem in proceeding with the procedure. Press [Next] to move to the next step.

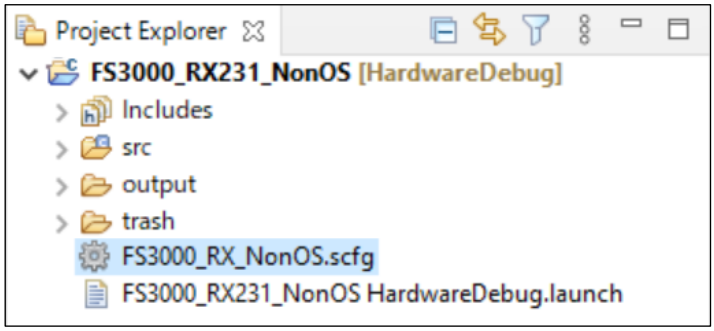



4. The changes you have made in the settings will be displayed. Press the [Finish] button to apply the changes to the project.



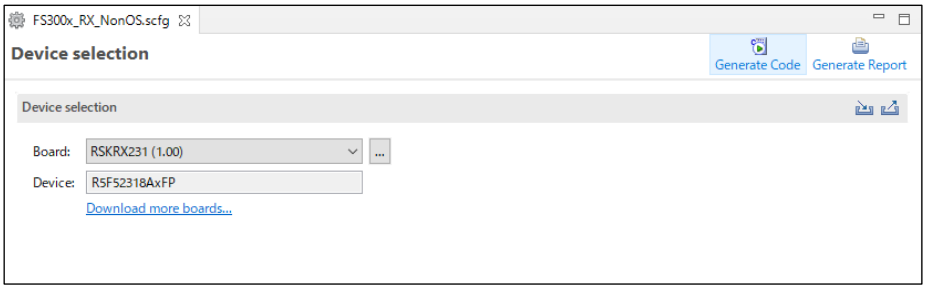
### 6.2.3 Modifying Settings of Smart Configurator

On the project tree, double-click on the .scfg file of the imported project in which the target device has been changed; the Smart Configurator window will open.



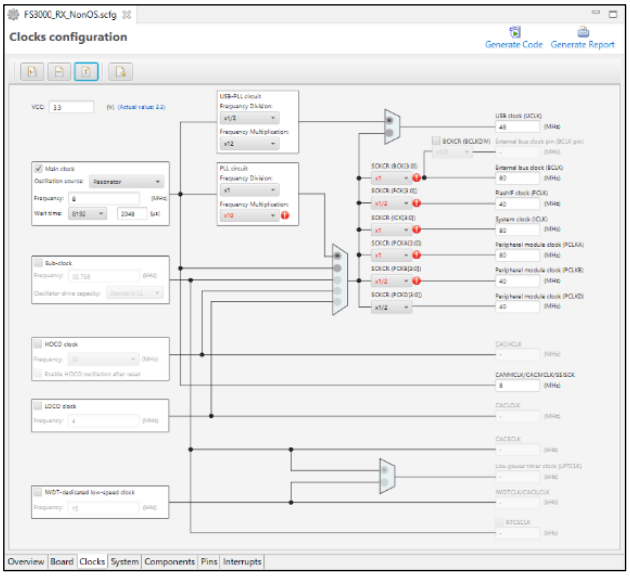

#### (1) Board

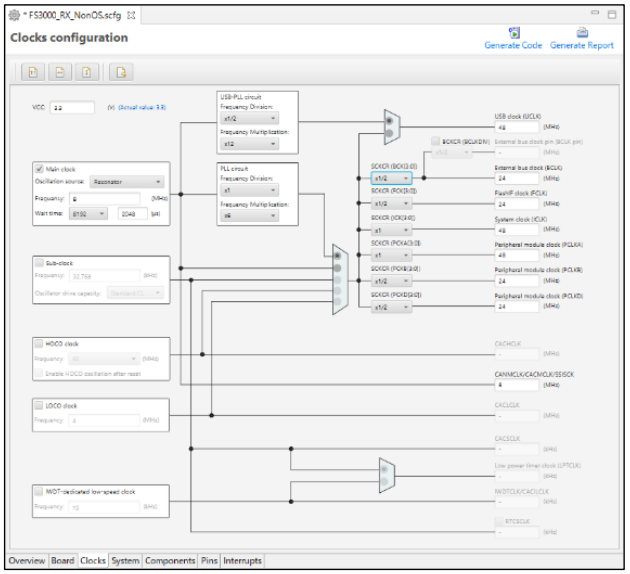
Select the "Board" tabbed page to check that the board and device have been changed correctly.




#### (2) Clocks

Set up the clocks in the "Clocks" tabbed page according to the specifications of the target board to be used.



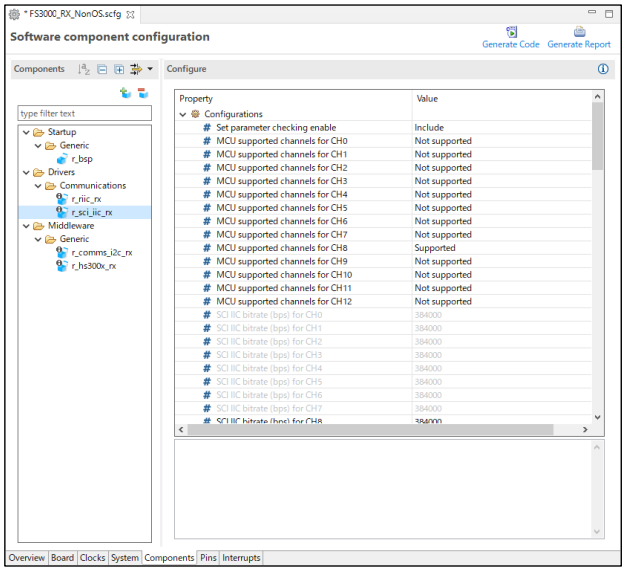
### (3) Components

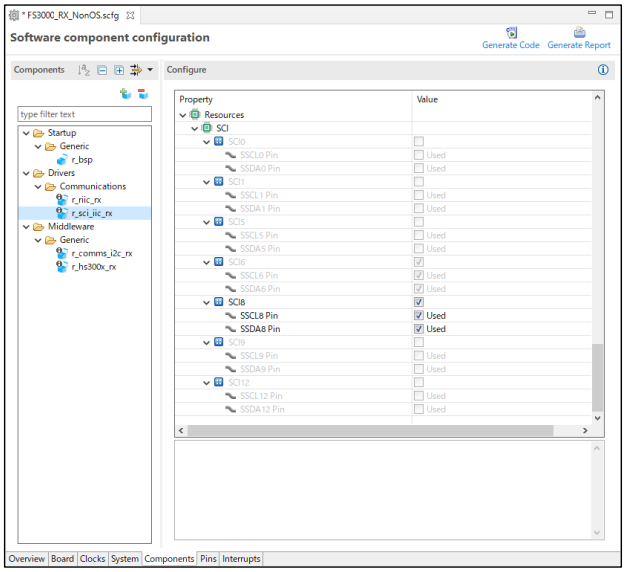
Modify the settings of individual components in the "Components" tabbed page according to the specifications of the target board.

#### (a) Changing I2C Driver Settings

As SCI8 is assigned to Pmod on the RSK-RX231 board, change the setting of "MCU supported channels for CH2" to "Not supported" and "MCU supported channels for CH8" to "Supported" in r_sci_iic_rx.

Check the settings of "SSCL8 Pin" and "SSDA8 Pin" for "SCI8" under "Resources".




#### (b) Changing COMMS_I2C Settings

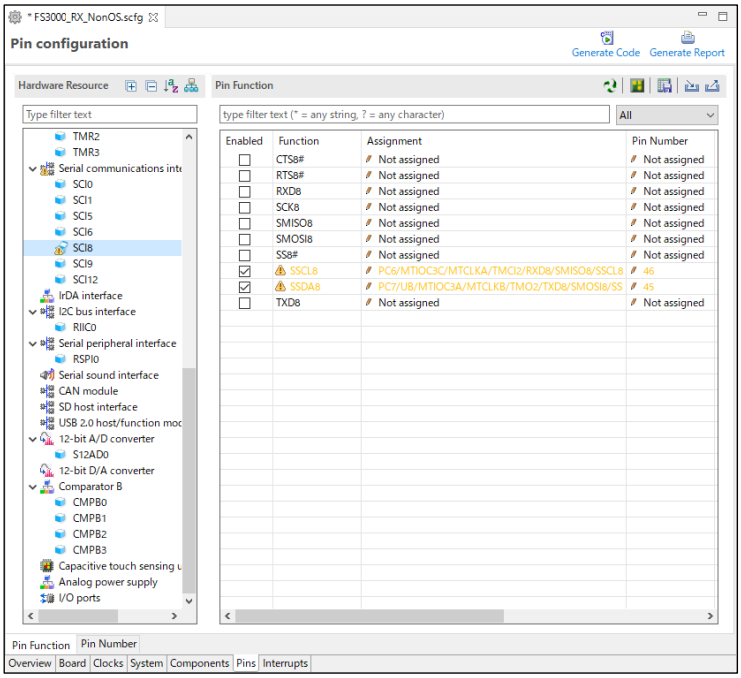
If you have changed the I2C driver or channel, you will need to change this settings.

When used SCI8, change the settings of “Channel No. for I2C Shared Bus0” to “8” in r_comms_i2c_rx.

### (4) Pins

### (a) Changing I2C I/F Pins

Open the "Pins" tabbed page and check that functions are assigned to the SCI8 pins in the "Pin function" panel.

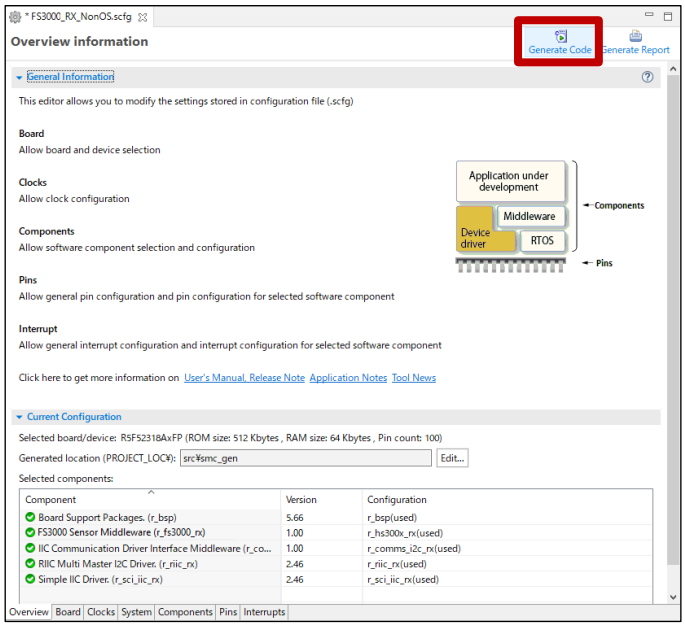



As the use of Pmod Type 2A is specified in the RSK-RX231 board information, a warning message will appear when I2C is used, but this does not produce any problems.

To connect the sensor board, an interposer board that converts Pmod Type 2A to Pmod Type 6A is required.

### (5) Code Generation and Build

Press the [Generate Code] icon to generate code.




Build the project.

Select [Debug Configurations] from the menu and modify the debugger settings according to the specifications of the emulator to be connected to the target board.

## 6.2.4 Changing Toolchain Setting

If you want to use a toolchain other than the CC-RX toolchain, copy main.c and RX_FS3000.c (Non-OS), or main.c and fs3000_sensor_thread_entry.c (FreeRTOS) from this project to create a new project.

## 6.3 RL78 Sample Project

Use the following procedures to modify a sample project.

The following explains the change procedure for the following board change example.

- Sample project "FS3000_RL78G23_NonOS":
  PMOD2 (Type 6A: IICA1)
  → Grove (IICA0) of the RL78/G22 Fast Prototyping Board

Set J17 to 2-3 to change Grove's VDD to 3.3V.

Also, connect with jumper wires as shown below.

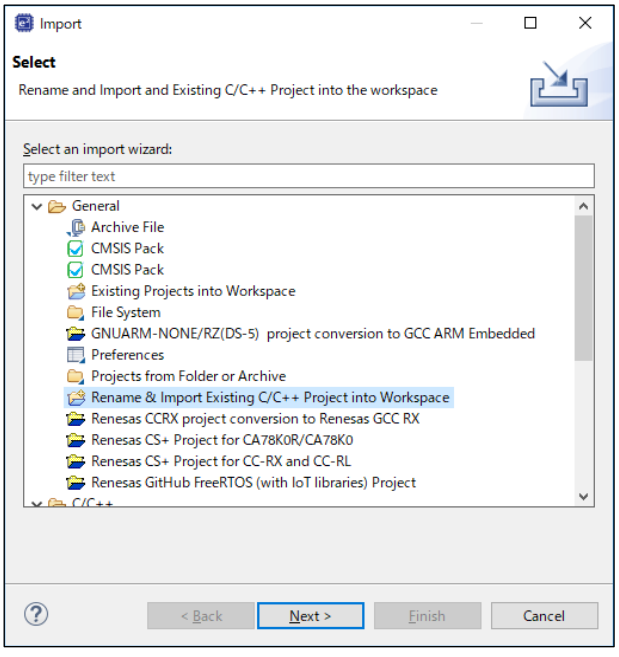
| RL78/G22 Fast Prototyping Board (Grove) | | |
|---|---|---|
| **Pin** | **Function** | **IICA I/F, Power supply** |
| #1 | SCL | **SCLA0** |
| #2 | SDA | **SDAA0** |
| #3 | VCC | **3.3V** |
| #4 | GND | **GND** |

| Renesas Pmod Type 6A Sensor Board | |
|---|---|
| **Pin** | **Function** |
| #1 | IRQ |
| #2 | RESET |
| #3 | **IIC_SCL** |
| #4 | **IIC_SDA** |
| #5 | **GND** |
| #6 | **VCC** |
| #7 | BUSY# |
| #8 | ENABLE |
| #9 | POWER_ON |
| #10 | GPIO |

### 6.3.1 Creating a New Project

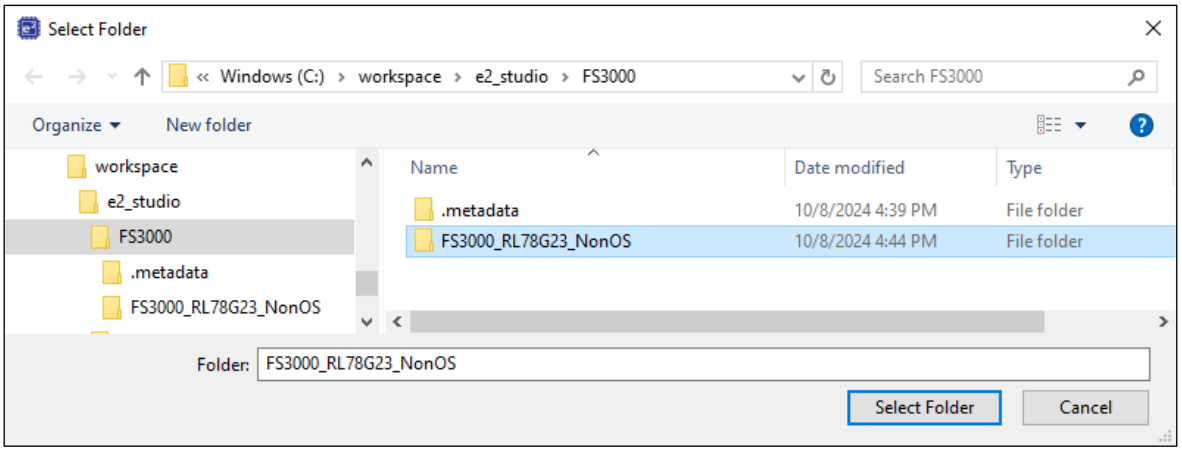
1. Select [Import] from the menu.

The "Import" window will appear. Select "Rename & Import Existing C/C++ Project into Workspace" in the window and press the [Next] button.

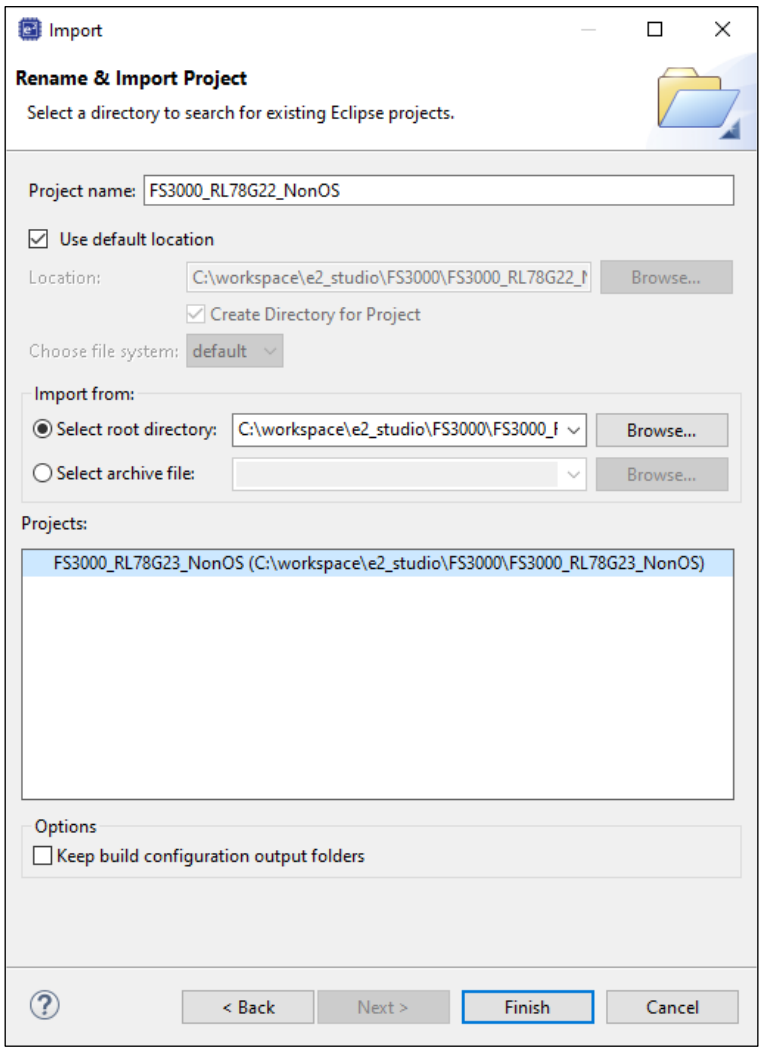


2. Press the [Browse] button to open the "Select Folder" window.

Select the folder of the original project for the current device from a list of imported sample projects and press the [Select Folder] button.

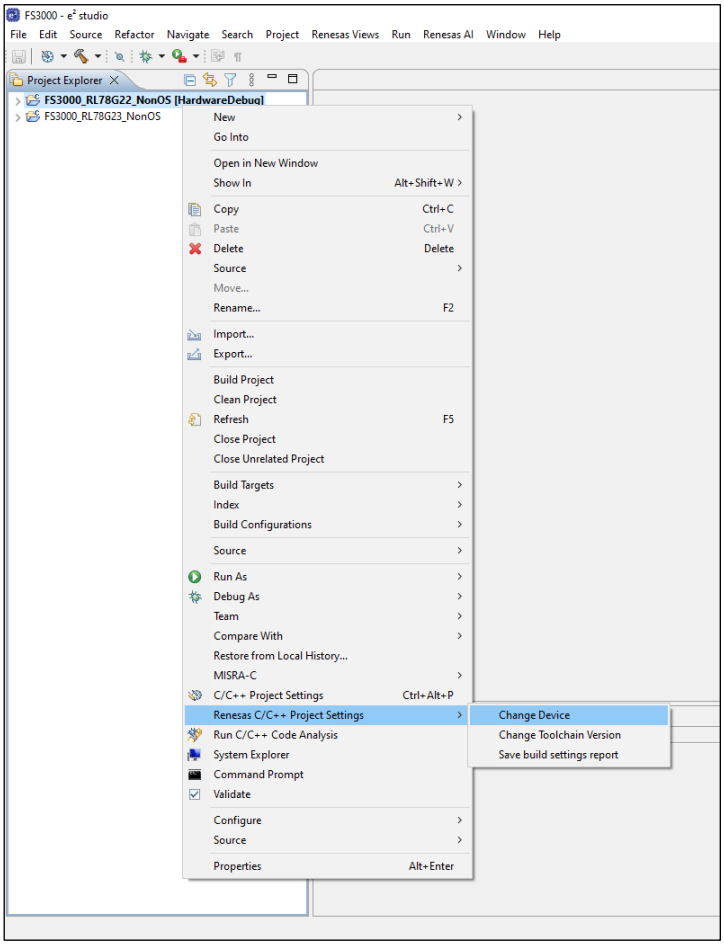



3. Enter the project name, select the original project for the current device, and press the [Finish] button.

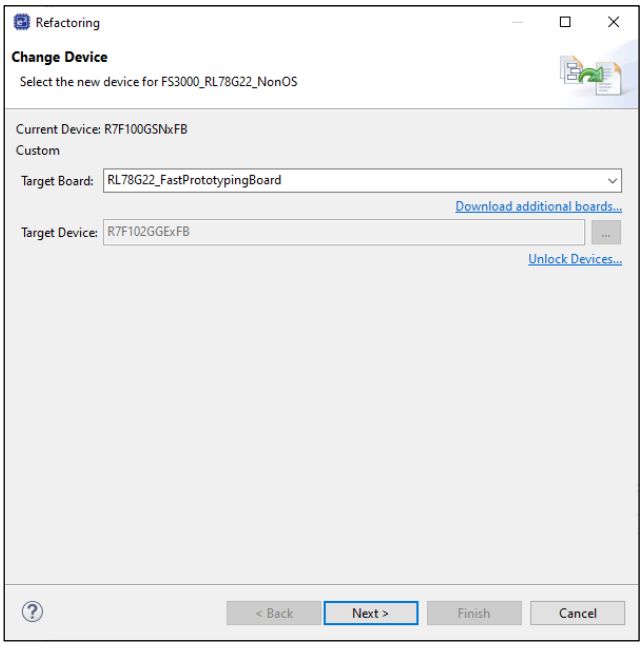


### 6.3.2 Changing Device

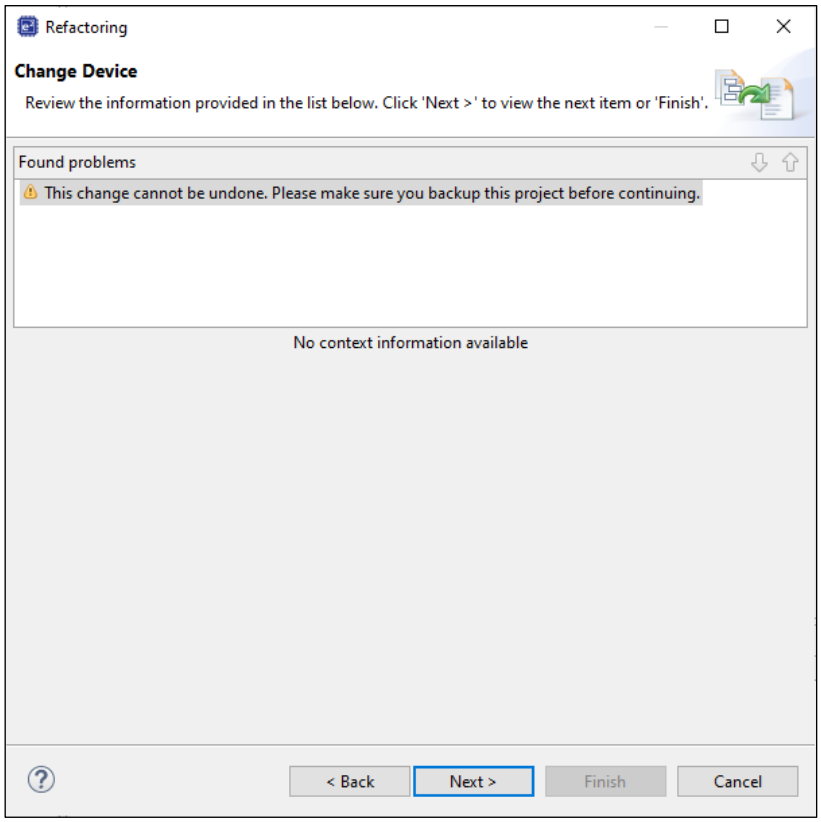
1. Select the imported project from the project tree and right-click on int to open the context menu. Select "Change Device" from the menu.



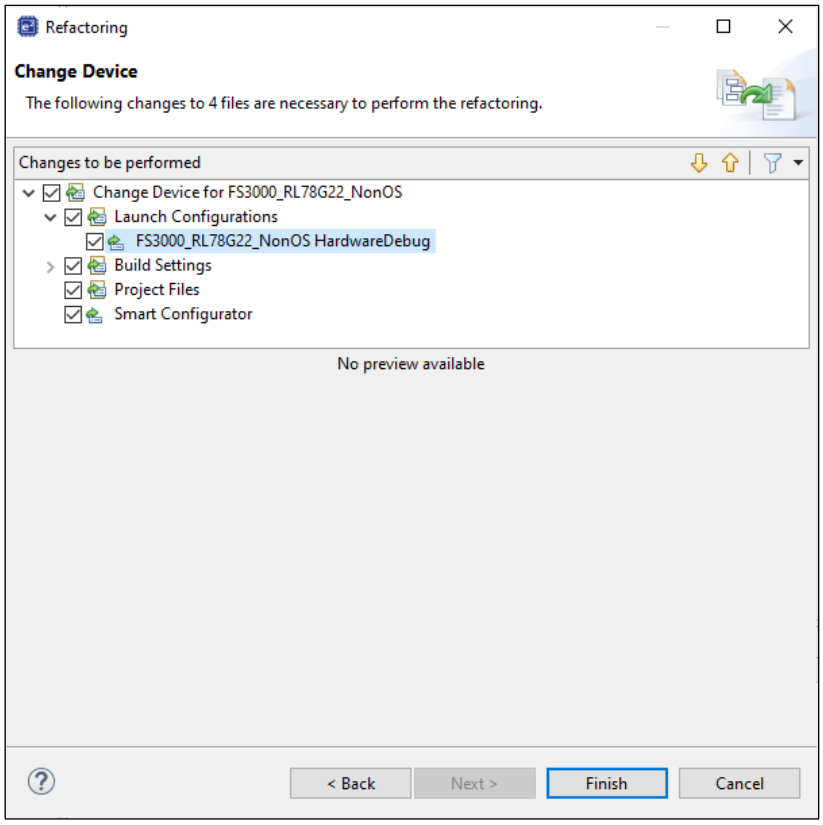

2. Select a desired board or device in the "Change Device" window and press the [Next] button.



3. If a warning message appears, read it and check if there is a problem in proceeding with the procedure. Press [Next] to move to the next step.

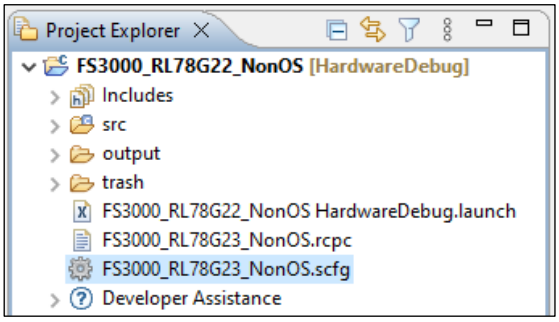



4. The changes you have made in the settings will be displayed. Press the [Finish] button to apply the changes to the project.



### 6.3.3 Modifying Settings of Smart Configurator

On the project tree, double-click on the .scfg file of the imported project in which the target device has been changed; the Smart Configurator window will open.



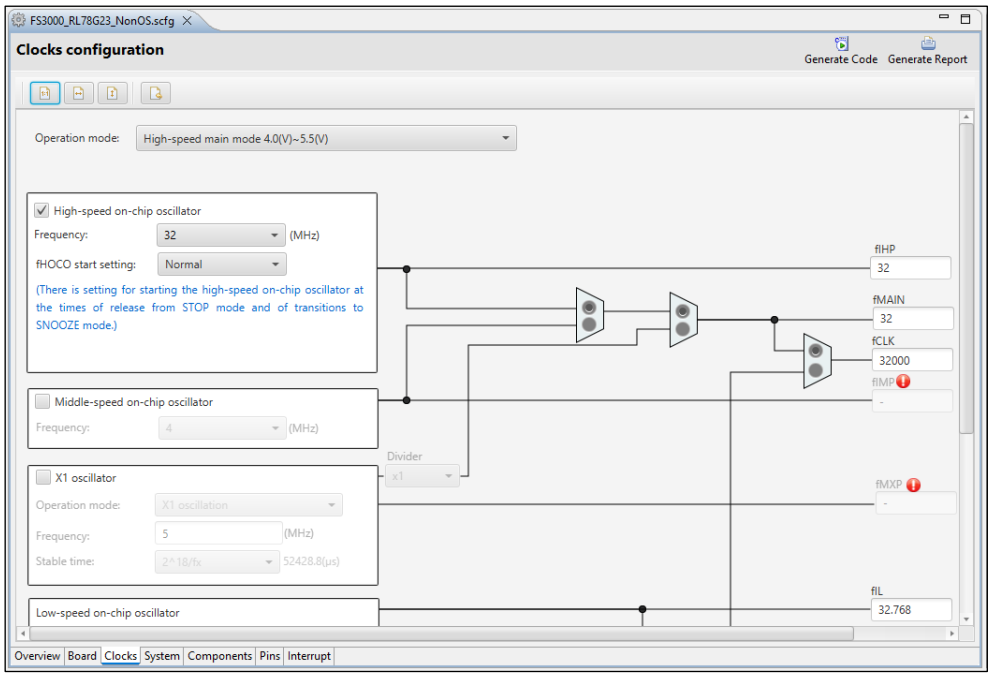

#### (1) Board

Select the "Board" tabbed page to check that the board and device have been changed correctly.

When the board and device has not been changed, click the [...] button and change the device again in the "Change Device" window.


#### (2) Clocks

Set up the clocks in the "Clocks configuration" tabbed page according to the specifications of the target board to be used.



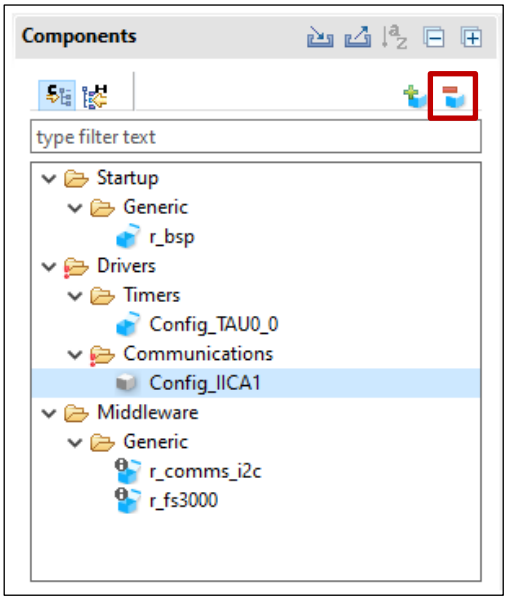
### (3) Components

Modify the settings of individual components in the "Components" tabbed page according to the specifications of the target board.

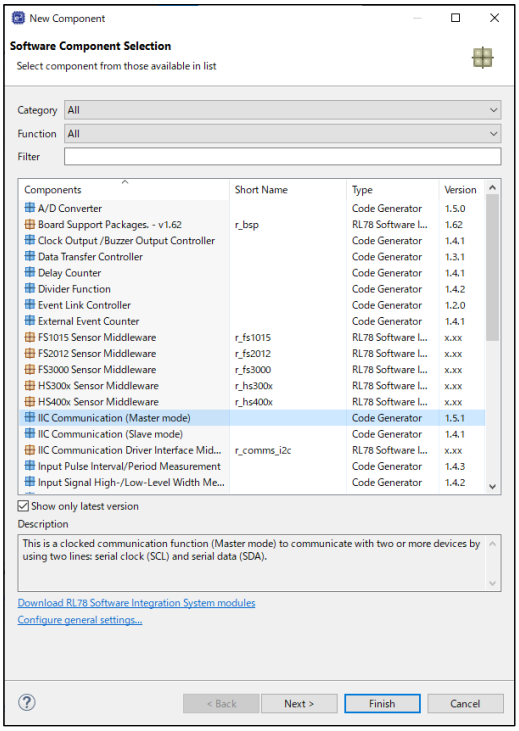
#### (a) Changing I2C Driver Settings

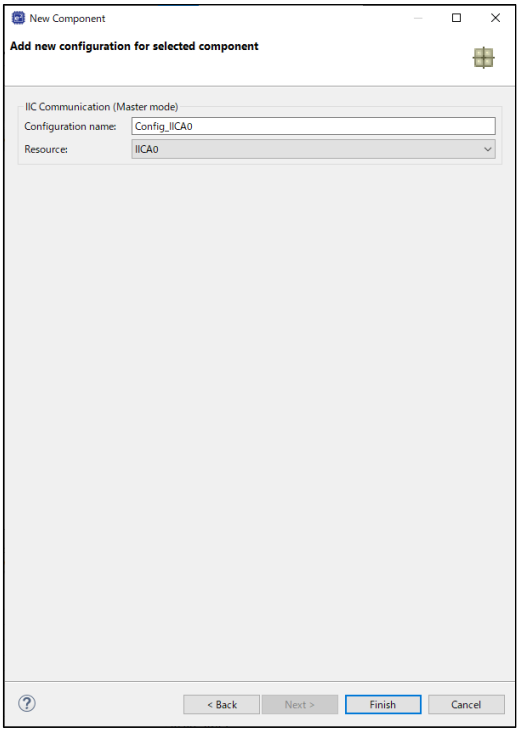
An SAU cannot be used because it does not support the clock stretching function required by FS3000 sensor.

1. In RL78/G22, the only resource that can be used as IICA is IICA0, so delete Config_IICA1.

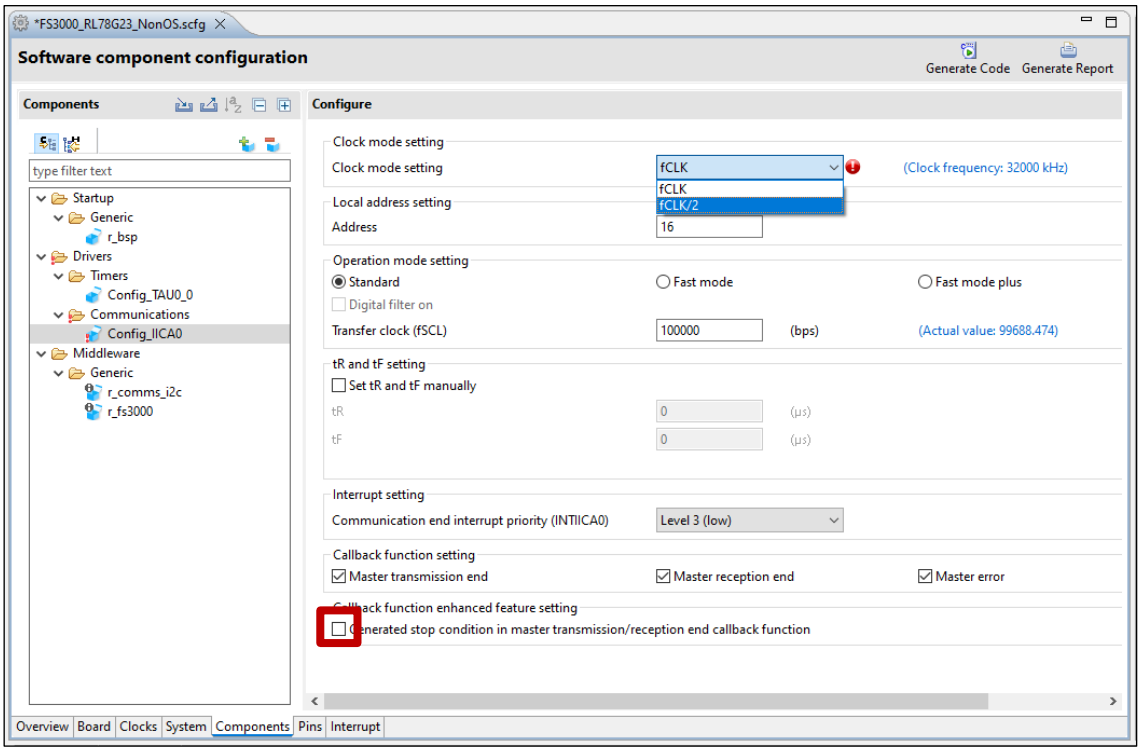



2. In "Software Component Selection", select "IIC Communication (Master Mode)" and specify "IICA0" as the resource.



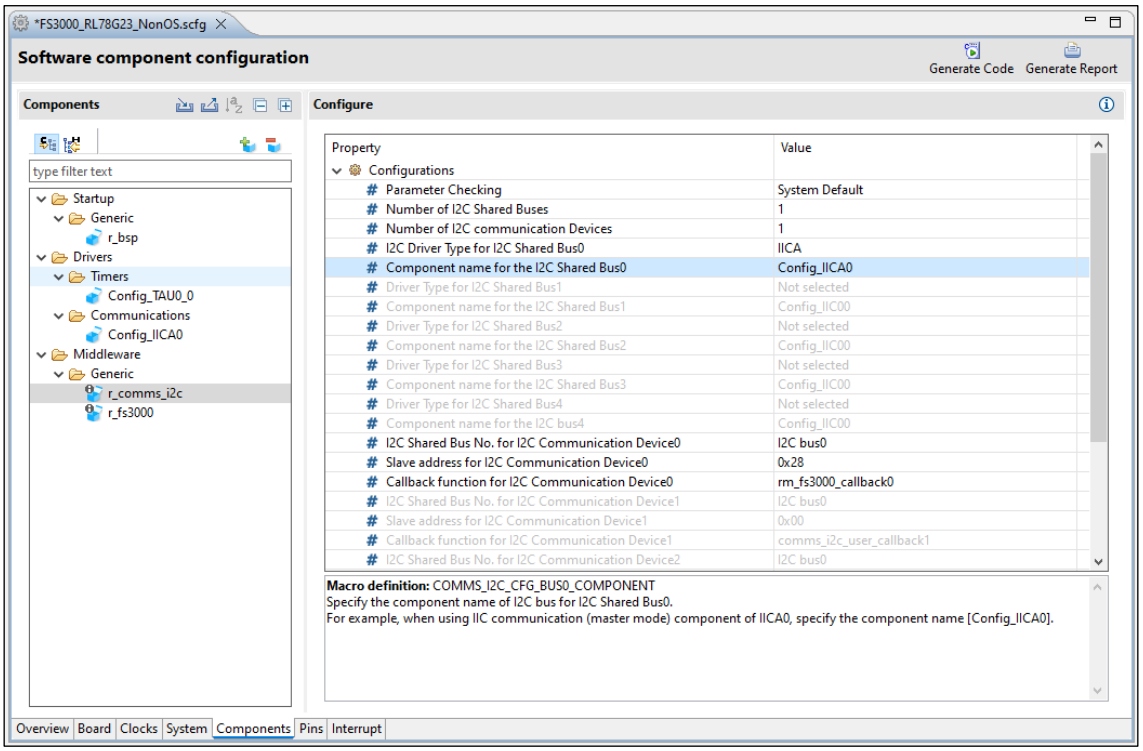
3. Change the setting of "Clock mode setting" to "fCLK/2" and uncheck "Generated stop condition in master transmission/reception end callback function".




### (b) Changing COMMS_I2C Settings

Review the settings to make sure they are appropriate. If you have changed the I2C driver, you will need to review them.

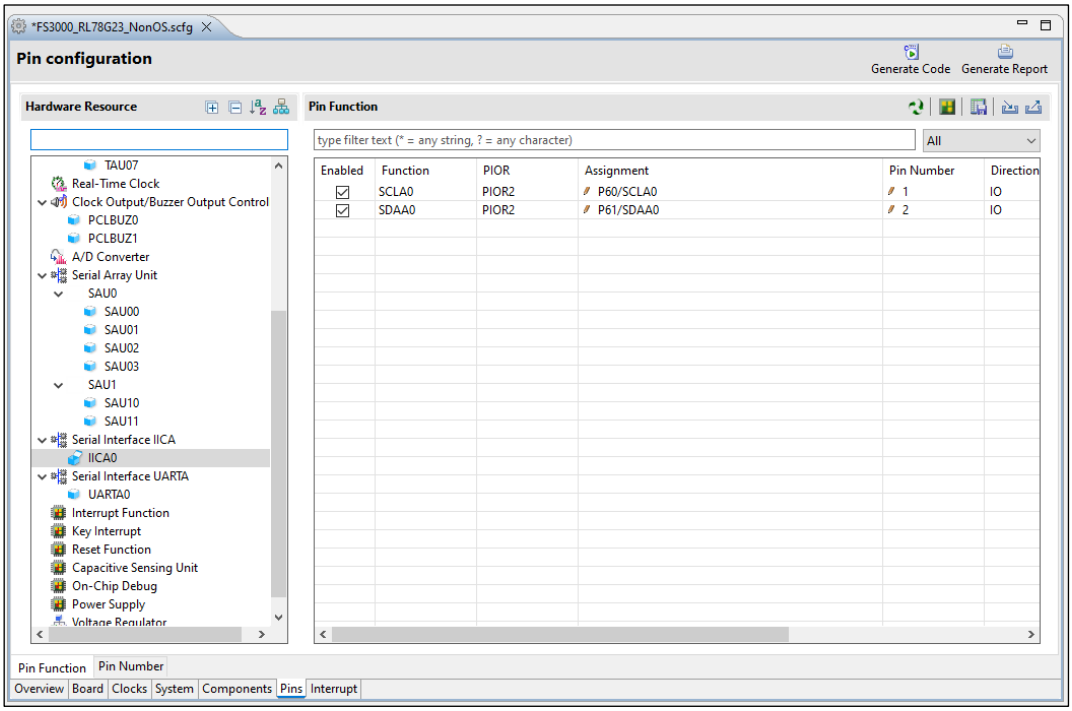
Change the setting of "Component name for the I2C Shared Bus0" to "Config_IICA0" in r_comms_i2c.



### (4) Pins

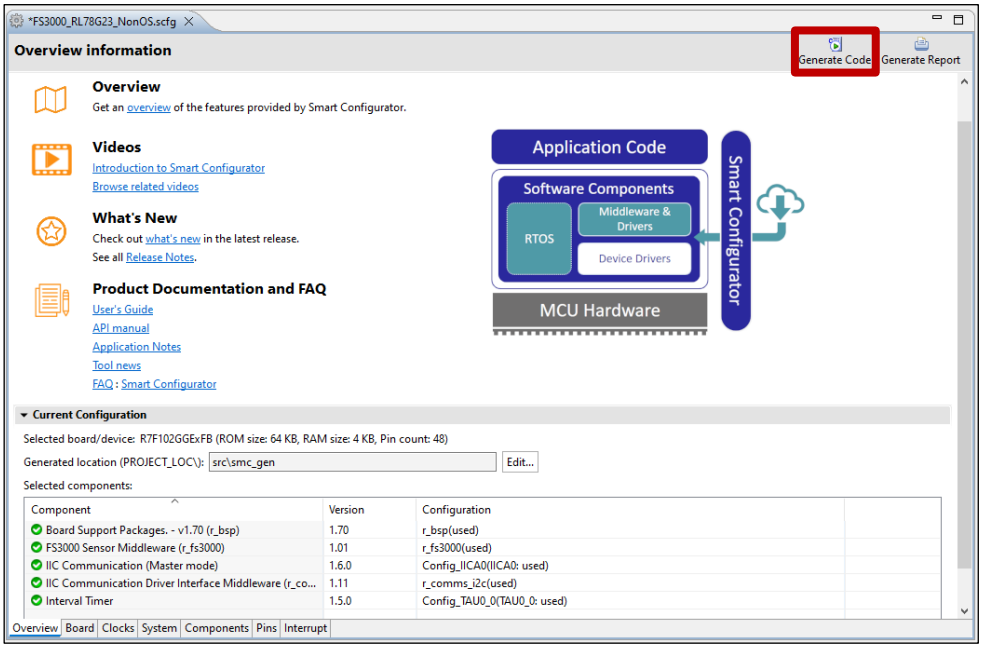
#### (a) Changing I2C I/F Pins

Open the "Pins" tabbed page and check that functions are assigned to the IICA pins in the "Pin function" panel.




### (5) Code Generation and Build

Press the [Generate Code] icon to generate code.




Build the project after implementing “6.3.4 Modifying Generated Code”.

Select [Debug Configurations] from the menu and modify the debugger settings according to the specifications of the emulator to be connected to the target board.

### 6.3.4 Modifying Generated Code

Open Config_IICA0_user.c and add the following code.

Definition for including r_comms_i2c_if.h:

```
/***********************************************************************
Includes
***********************************************************************/
#include "r_cg_macrodriver.h"
#include "r_cg_userdefine.h"
#include "Config_IICA0.h"
/* Start user code for include. Do not edit comment generated here */
#include "r_comms_i2c_if.h"
/* End user code. Do not edit comment generated here */
```

Addition of the rm_comms_i2c_bus0_callback() function to the callback function:

Specify the "false" parameter for the transmission and reception end callback functions and the "true" parameter for the error callback function.

```
/***********************************************************************
* Function Name: r_Config_IICA0_callback_master_sendend
* Description  : This function is a callback function when IICA0 finishes master
transmission.
* Arguments    : None
* Return Value : None
***********************************************************************/
static void r_Config_IICA0_callback_master_sendend(void)
{
/* Start user code for r_Config_IICA0_callback_master_sendend. Do not edit comment
generated here */
  rm_comms_i2c_bus0_callback(false);
/* End user code. Do not edit comment generated here */
}

/***********************************************************************
* Function Name: r_Config_IICA0_callback_master_receiveend
* Description  : This function is a callback function when IICA0 finishes master
reception.
* Arguments    : None
* Return Value : None
***********************************************************************/
static void r_Config_IICA0_callback_master_receiveend(void)
{
/* Start user code for r_Config_IICA0_callback_master_receiveend. Do not edit comment
generated here */
  rm_comms_i2c_bus0_callback(false);
/* End user code. Do not edit comment generated here */
}

/***********************************************************************
* Function Name: r_Config_IICA0_callback_master_error
* Description  : This function is a callback function when IICA0 master error occurs.
* Arguments    : flag -
*                  status flag
* Return Value : None
***********************************************************************/
static void r_Config_IICA0_callback_master_error(MD_STATUS flag)
{
    /* Start user code for r_Config_IICA0_callback_master_error. Do not edit comment
generated here */
  rm_comms_i2c_bus0_callback(true);
    /* End user code. Do not edit comment generated here */
}
```

### 6.3.5 Changing Toolchain Setting

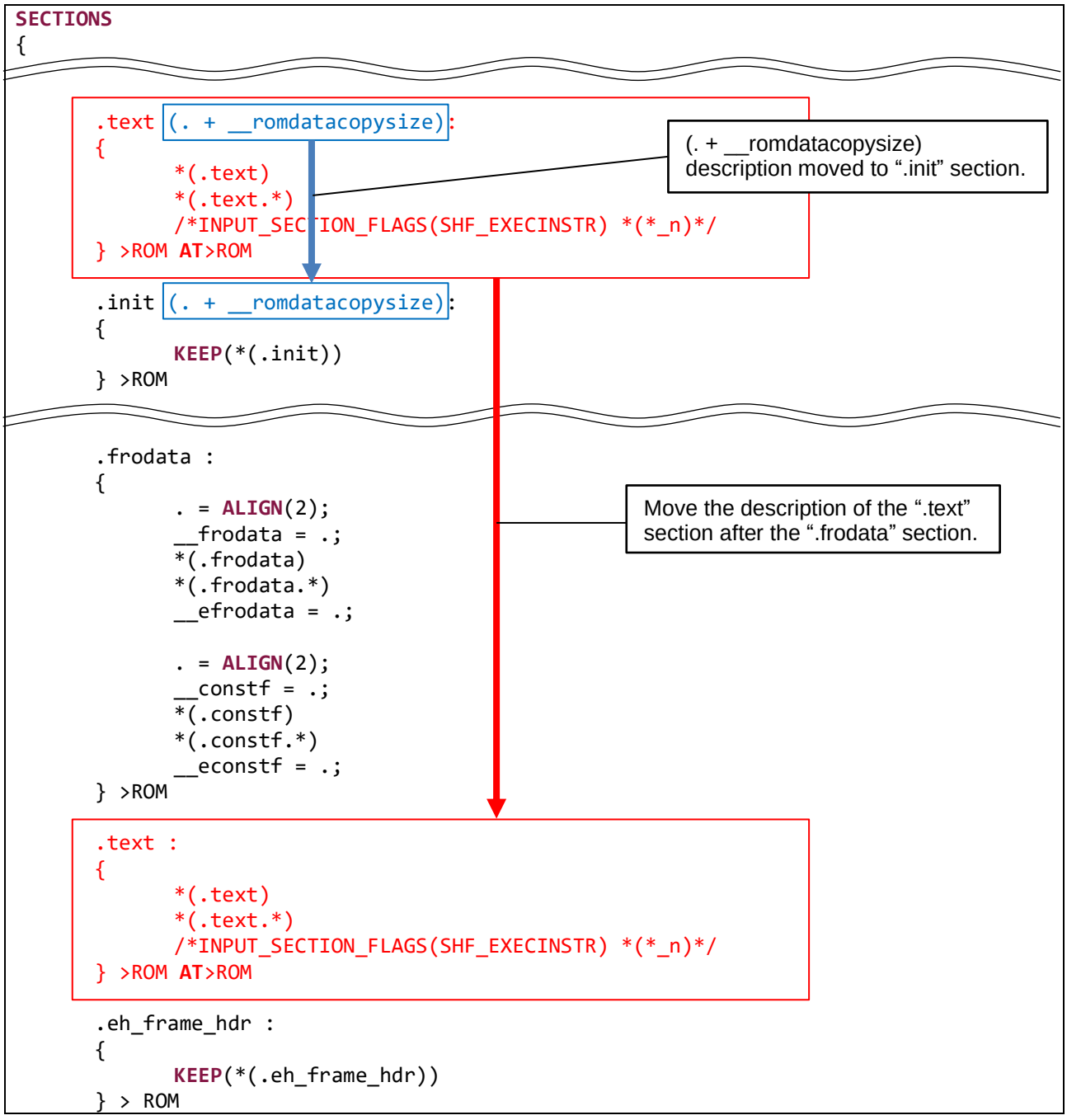
If you want to use a toolchain the LLVM toolchain, use “FS3000_RL78G23_NonOS_LLVM”.

If you want to use a toolchain other than the CC-RL toolchain or LLVM toolchain, copy FS3000_RL78G23_NonOS.c and RL78_FS3000.c from this project to create a new project.

Also, when using the LLVM toolchain, build errors may occur due to section placement. In this case, the linker script must be modified.

The following describes an example of modifying linker_script.ld in the sample project “FS3000_RL78G23_NonOS_LLVM”.

1. Place the “.text” section after the “.frodata” section.



2. Fix the address of the ".rodata" section to the top address of the mirror area.

```
        .fini :
        {
                KEEP(*(.fini))
        } >ROM

        PROVIDE(__rodata_limit = CONSTANT(MIRRORAREASTART)+ 0x3000 + LENGTH(MIRROR));

        /* The rodata section is placed in MIRROR area in order to access as near
addressing. */
        .rodata MAX(., (CONSTANT(MIRRORAREASTART)+ 0x3000));
        .rodata 0x3000 : AT(0x3000)
        {
                . = ALIGN(2);
                __rodata = .;
                *(.rodata)
                *(.rodata.*)
                . = ALIGN(2);
```

Change the address of the ".rodata" section to 0x3000.

3. Change the ".data" section to the address after the ".ocd_traceram" section.

```
        .eh_frame :
        {
                KEEP(*(.eh_frame))
        } > ROM

        .ocd_traceram 0xf4300 (NOLOAD) : AT(0xf4300)
        {
                KEEP(*(.ocd_traceram))
        } >RAM

        .data 0xF4700 : AT(__mdata)
        {
                . = ALIGN(2);
                PROVIDE (__datastart = .);

        .bssf (NOLOAD):
        {
                PROVIDE(__bssfstart = .);
                . = ALIGN(2);
                *(.bssf)
                *(.bssf.*)
                /*INPUT_SECTION_FLAGS(!SHF_EXECINSTR, SHF_WRITE, SHF_ALLOC) *(*_f)*/
                . = ALIGN(128);
                __end = .;
        } >RAM AT>RAM
        PROVIDE(__bssfsize = SIZEOF(.bssf));

        PROVIDE(__stack_size = 0x100);
        .ocd_traceram 0xf4300 (NOLOAD) : AT(0xf4300)
        {
                KEEP(*(.ocd_traceram))
        } >RAM
        .stack 0xFFE20 (NOLOAD) : AT(0xFFE20)
        {
                PROVIDE(__stack = .);
```

Change the address of the ".data" section to 0xF4700.

Move the description in the ".ocd_traceram" section before the ".data" section.

Note: Changing the section address reduces the available ROM / RAM area.

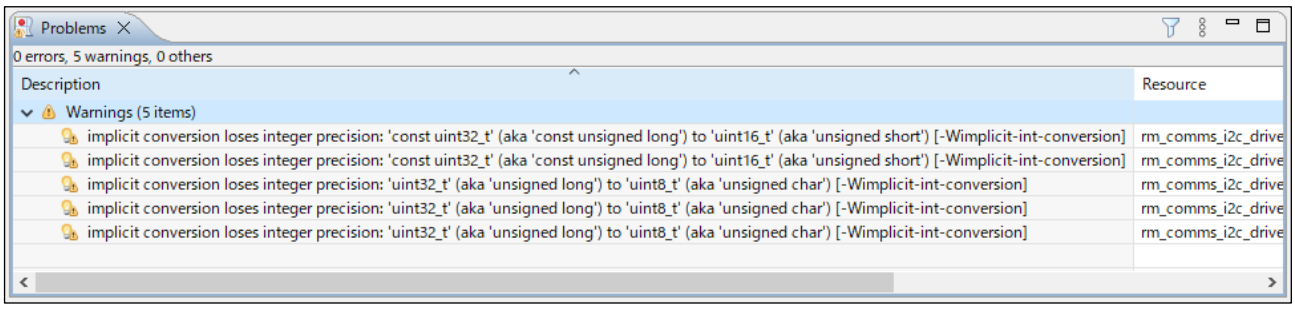
### 6.3.6 Notes for Build on LLVM

The following Warning occurs when building an LLVM project.

These Warnings are occurring because “slave_address” and “bytes” used in COMMS_I2C are handled as 32-bit type.

Since “slave_address” is 7-bit data and “bytes” is 16-bit data, no loss occurs due to conversion.

Warning messages will appear, but this does not affect the operation.



## 6.4 Notes for Interrupt Signal Circuits

FS3000 does not have an Interrupt request signal pin.

Also, since the FS3000 sensor Pmod board does not have the pull-up resistor circuit and interrupt signal circuit, there are no precautions to take when daisy-chaining Renesas sensor Pmod boards.

## 6.5 Notes for RESET Signal Circuits

FS3000 does not have a RESET input signal pin.

Also, since the FS3000 sensor Pmod board does not have the pull-up resistor circuit, there are no precautions to take when daisy-chaining Renesas sensor Pmod boards.

## 6.6 Pull-up Resister Circuit Configuration when Daisy Chain Connections of Renesas Sensor Pmod Boards

The recommended method for connecting the pull-up resistors in a daisy chain is shown below. Also, disable the pull-ups on other Renesas Sensor boards.

If the pull-up resistors of many Renesas Sensor boards are enabled at the same time, the sensor boards may not function properly.

**Table 6-2 Target Board that Enable Pull-up Resistors when Daisy-chaining**

| Pmod Sensor Board Type 6A Singal Name | Recommended Circuit Configuration of Pull-up Resisters |
|---|---|
| #1: IRQ# (Note 1) | Enable only the board closest to the MCU board for boards with pull-up resistor circuits. |
| #2: RESET# (Note 1) | Enable only the board closest to the MCU board for boards with pull-up resistor circuits. |
| #3: SCL | Enable only the board closest to the MCU board for boards. |
| #4: SDA | Enable only the board closest to the MCU board for boards. |
| #7: BUSY# (Note 1, 2) | Enable only the board closest to the MCU board for boards with pull-up resistor circuits. |

Note 1 There are the board without the pull-up resisters.

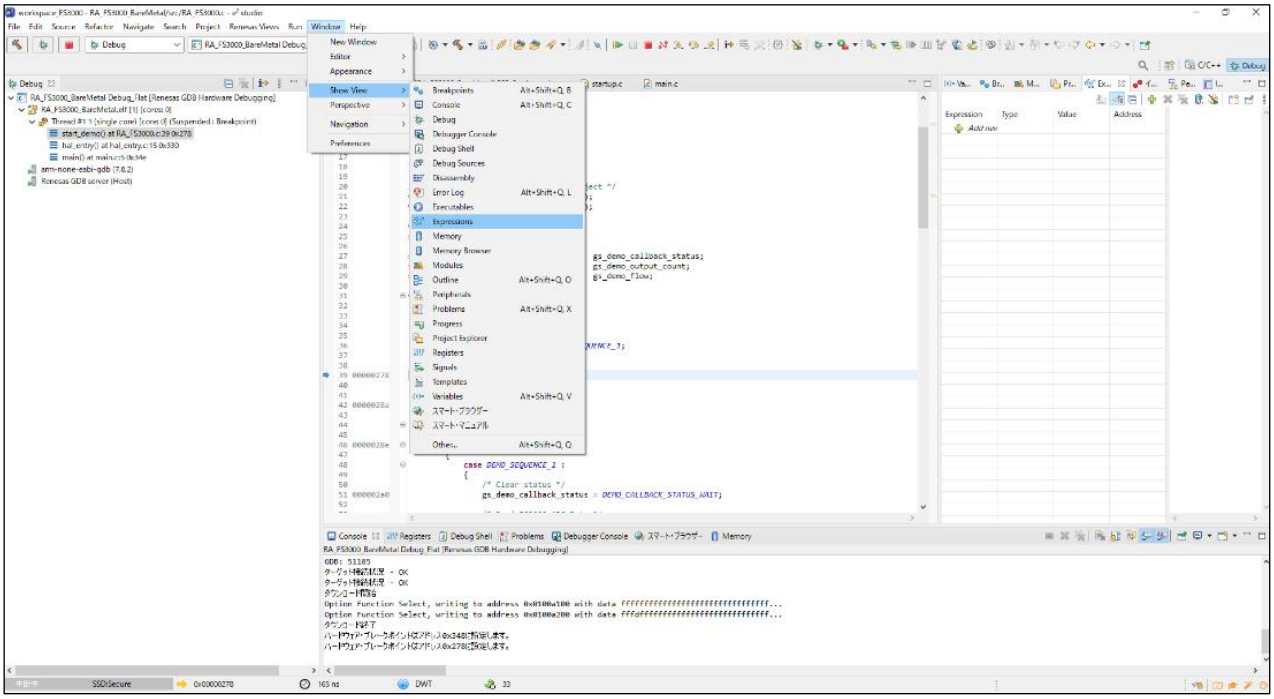
Note 2 Configure when using as an Interrupt signal

# 7. Viewing Air Velocity Data

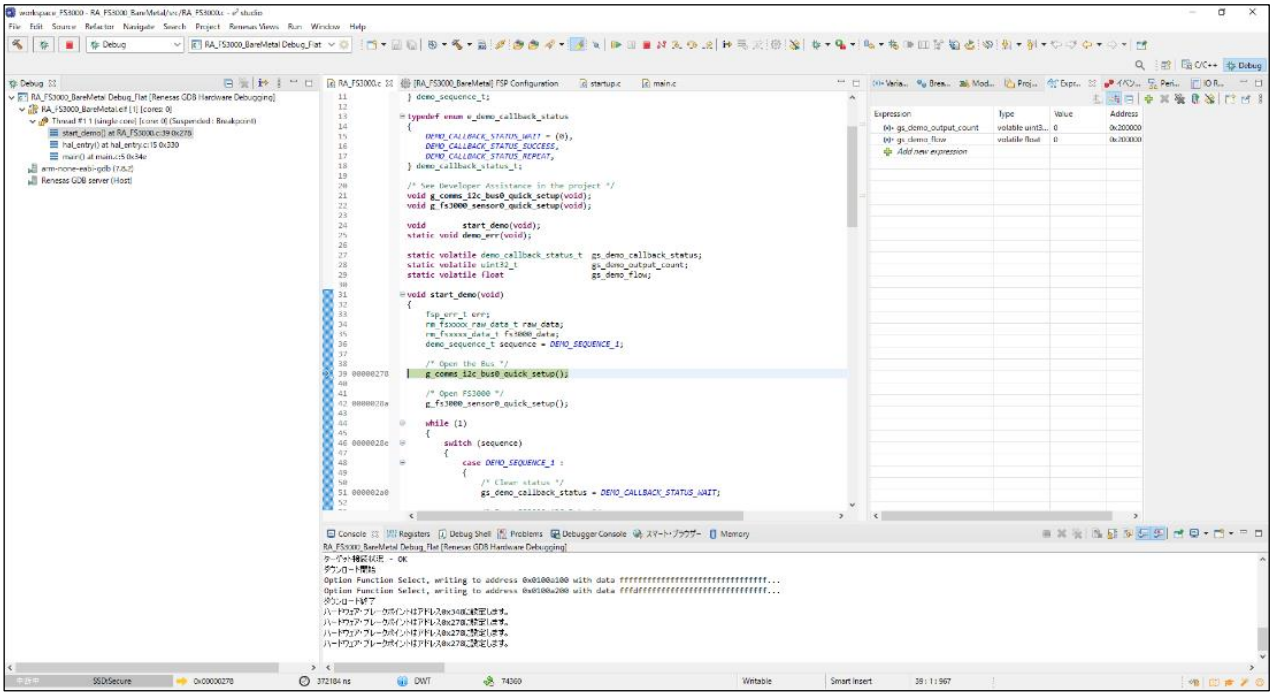
Use the following procedure to view air velocity data in real time.

1. After running the Debug, open the “Expressions” window.

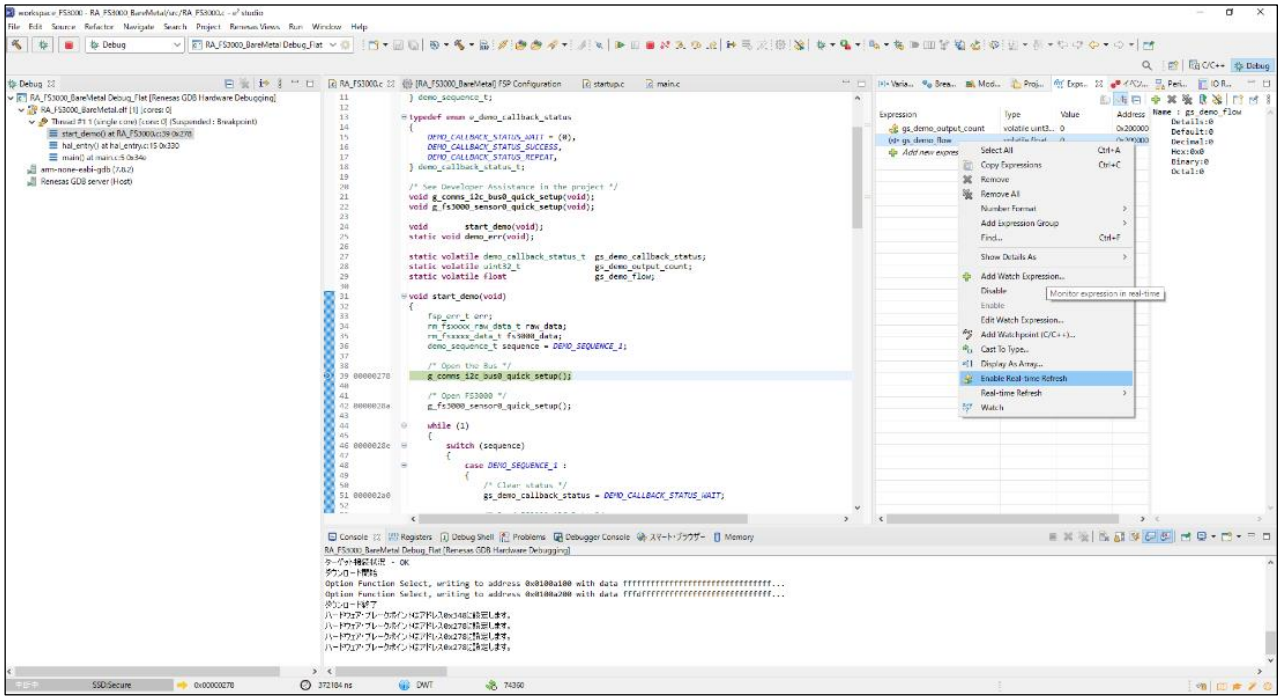
“Expressions” window is available from [Window]→[Show View]→[Expressions].



2. Click “Add new expression” in the “Expressions” and add “gs_fs3000_data”.

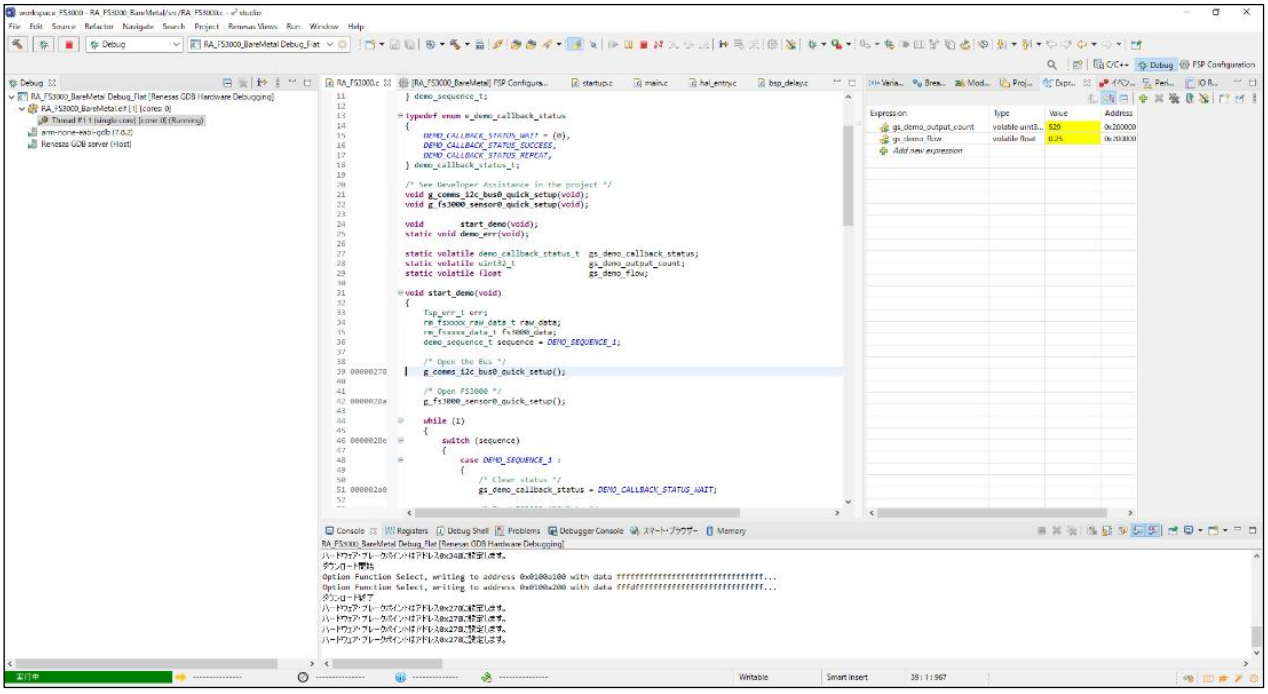


3. Right-click on the added variable and select the “Enable Real-time Refresh”.



4. Start the Debug.

It is possible to check the real-time values.



Revision History

| Rev. | Date | Description | |
|---|---|---|---|
| | | Page | Summary |
| 1.00 | June 30, 2022 | - | First Release |
| 1.01 | March 3, 2023 | - | Updated: environments for RL78 |
| 1.02 | March 29, 2023 | - | Updated: Environments for RA, RX, RL78, RZ<br>Updated: Main Processing Flow of Sample Software<br>Updated: Guide for Changing the Target Device |
| 1.03 | September 7, 2023 | - | Updated: Guide for Changing the Target Device<br>Deleted: RE01 items |
| 1.04 | Dec.10.24 | - | Added: FS3000-1015<br>Added: Terms/Abbreviations<br>Updated: Environments for RA, RL78<br>Updated: Sensor Specifications<br>Updated: Sample Software Specifications<br>Updated: Configuration Setting<br>Updated: Guide for Changing the Target Device for RA, RL78 |

# General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

   A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.
2. Processing at power-on

   The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.
3. Input of signal during power-off state

   Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.
4. Handling of unused pins

   Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.
5. Clock signals

   After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.
6. Voltage application waveform at input pin

   Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between $V_{IL}$ (Max.) and $V_{IH}$ (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between $V_{IL}$ (Max.) and $V_{IH}$ (Min.).
7. Prohibition of access to reserved addresses

   Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.
8. Differences between products

   Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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